

# TLV2442, TLV2442A, TLV2444, TLV2444A Advanced LinCMOS™ RAIL-TO-RAIL OUTPUT WIDE-INPUT-VOLTAGE OPERATIONAL AMPLIFIERS

SLOS169H – NOVEMBER 1996 – REVISED MARCH 2001

- Output Swing Includes Both Supply Rails
- Extended Common-Mode Input Voltage Range . . . 0 V to 4.25 V (Min) at 5-V Single Supply
- No Phase Inversion
- Low Noise . . . 16 nV/√Hz Typ at f = 1 kHz
- Low Input Offset Voltage  
950 μV Max at T<sub>A</sub> = 25°C (TLV244xA)
- Low Input Bias Current . . . 1 pA Typ
- 600-Ω Output Drive
- High-Gain Bandwidth . . . 1.8 MHz Typ
- Low Supply Current . . . 750 μA Per Channel Typ
- Macromodel Included
- Available in Q-Temp Automotive  
HighRel Automotive Applications  
Configuration Control/Print Support  
Qualification to Automotive Standards

## description

The TLV244x and TLV244xA are low-voltage operational amplifiers from Texas Instruments. The common-mode input voltage range of these devices has been extended over typical standard CMOS amplifiers, making them suitable for a wide range of applications. In addition, these devices do not phase invert when the common-mode input is driven to the supply rails. This satisfies most design requirements without paying a premium for rail-to-rail input performance. They also exhibit rail-to-rail output performance for increased dynamic range in single- or split-supply applications. This family is fully characterized at 3-V and 5-V supplies and is optimized for low-voltage operation. Both devices offer comparable ac performance while having lower noise, input offset voltage, and power dissipation than existing CMOS operational amplifiers. The TLV244x has increased output drive over previous rail-to-rail operational amplifiers and can drive 600-Ω loads for telecommunications applications.

The other members in the TLV244x family are the low-power, TLV243x, and micro-power, TLV2422, versions.

The TLV244x, exhibiting high input impedance and low noise, is excellent for small-signal conditioning for high-impedance sources, such as piezoelectric transducers. Because of the micropower dissipation levels and low-voltage operation, these devices work well in hand-held monitoring and remote-sensing applications. In addition, the rail-to-rail output feature with single- or split-supplies makes this family a great choice when interfacing with analog-to-digital converters (ADCs). For precision applications, the TLV244xA is available with a maximum input offset voltage of 950 μV.

If the design requires single operational amplifiers, see the TI TLV2211/21/31. This is a family of rail-to-rail output operational amplifiers in the SOT-23 package. Their small size and low power consumption make them ideal for high density, battery-powered equipment.

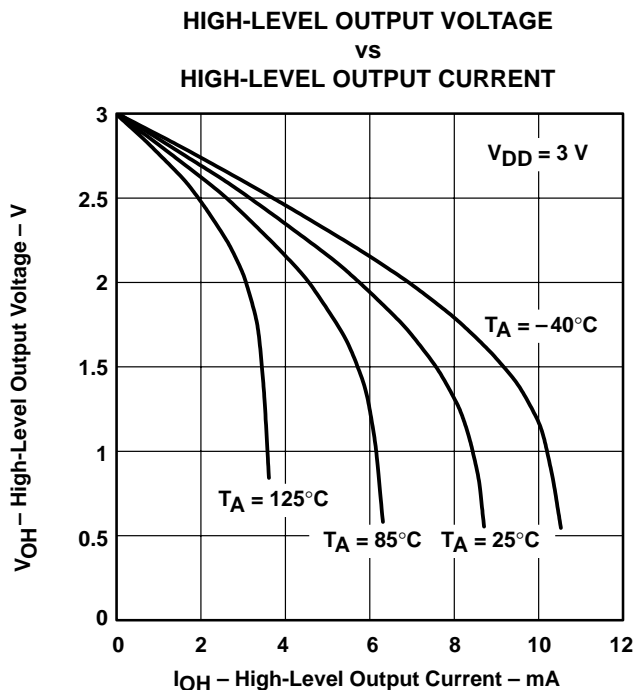


Figure 1



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

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**TEXAS  
INSTRUMENTS**

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# TLV2442, TLV2442A, TLV2444, TLV2444A

## Advanced LinCMOS™ RAIL-TO-RAIL OUTPUT

### WIDE-INPUT-VOLTAGE OPERATIONAL AMPLIFIERS

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#### TLV2442 AVAILABLE OPTIONS

| T <sub>A</sub> | V <sub>IO</sub> max<br>AT 25°C | PACKAGED DEVICES        |                           |                           |                           |                             |
|----------------|--------------------------------|-------------------------|---------------------------|---------------------------|---------------------------|-----------------------------|
|                |                                | SMALL<br>OUTLINE<br>(D) | CHIP CARRIER<br>(FK)      | CERAMIC DIP<br>(JG)       | TSSOP<br>(PW)             | CERAMIC FLAT<br>PACK<br>(U) |
| 0°C to 70°C    | 2.5 mV                         | TLV2442CD               | —                         | —                         | TLV2442CPW                | —                           |
| –40°C to 85°C  | 950 μV<br>2.5 mV               | TLV2442AID<br>TLV2442ID | —                         | —                         | TLV2442AIPW<br>—          | —                           |
| –40°C to 125°C | 950 μV<br>2.5 mV               | TLV2442AQD<br>TLV2442QD | —                         | —                         | TLV2442AQPW<br>TLV2442QPW | —                           |
| –55°C to 125°C | 950 μV<br>2.5 mV               | —                       | TLV2442AMFK<br>TLV2442MFK | TLV2442AMJG<br>TLV2442MJG | —                         | TLV2442AMU<br>TLV2442MU     |

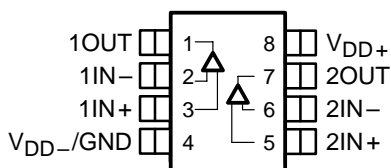
The D and PW packages are available taped and reeled. Add R suffix to device type (e.g., TLV2442CDR).

#### TLV2444 AVAILABLE OPTIONS

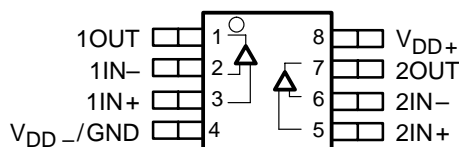
| T <sub>A</sub> | V <sub>IO</sub> max<br>AT 25°C | PACKAGED DEVICES        |                           |
|----------------|--------------------------------|-------------------------|---------------------------|
|                |                                | SMALL<br>OUTLINE<br>(D) | TSSOP<br>(PW)             |
| 0°C to 70°C    | 2.5 mV                         | TLV2444CD               | TLV2444CPW                |
| –40°C to 125°C | 950 μV<br>2.5 mV               | TLV2444AID<br>TLV2444ID | TLV2444AIPW<br>TLV2444IPW |

The D and PW packages are available taped and reeled. Add R suffix to device type (e.g., TLV2444CDR).

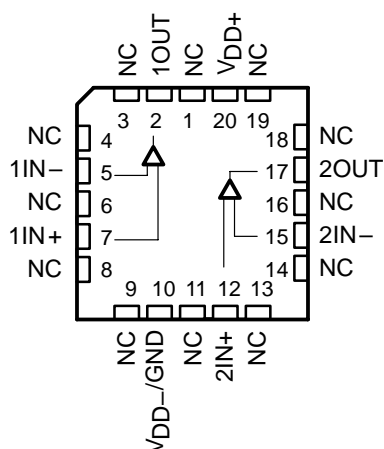
**TLV2442  
D OR JG PACKAGE  
(TOP VIEW)**



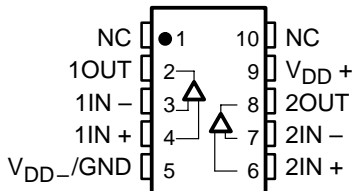
**TLV2442  
PW PACKAGE  
(TOP VIEW)**



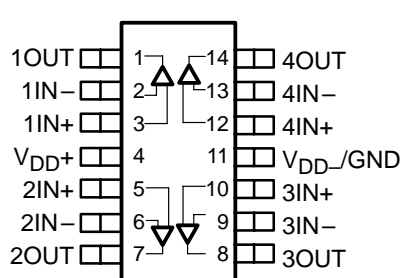
**TLV2442  
FK PACKAGE  
(TOP VIEW)**



**TLV2442  
U PACKAGE  
(TOP VIEW)**



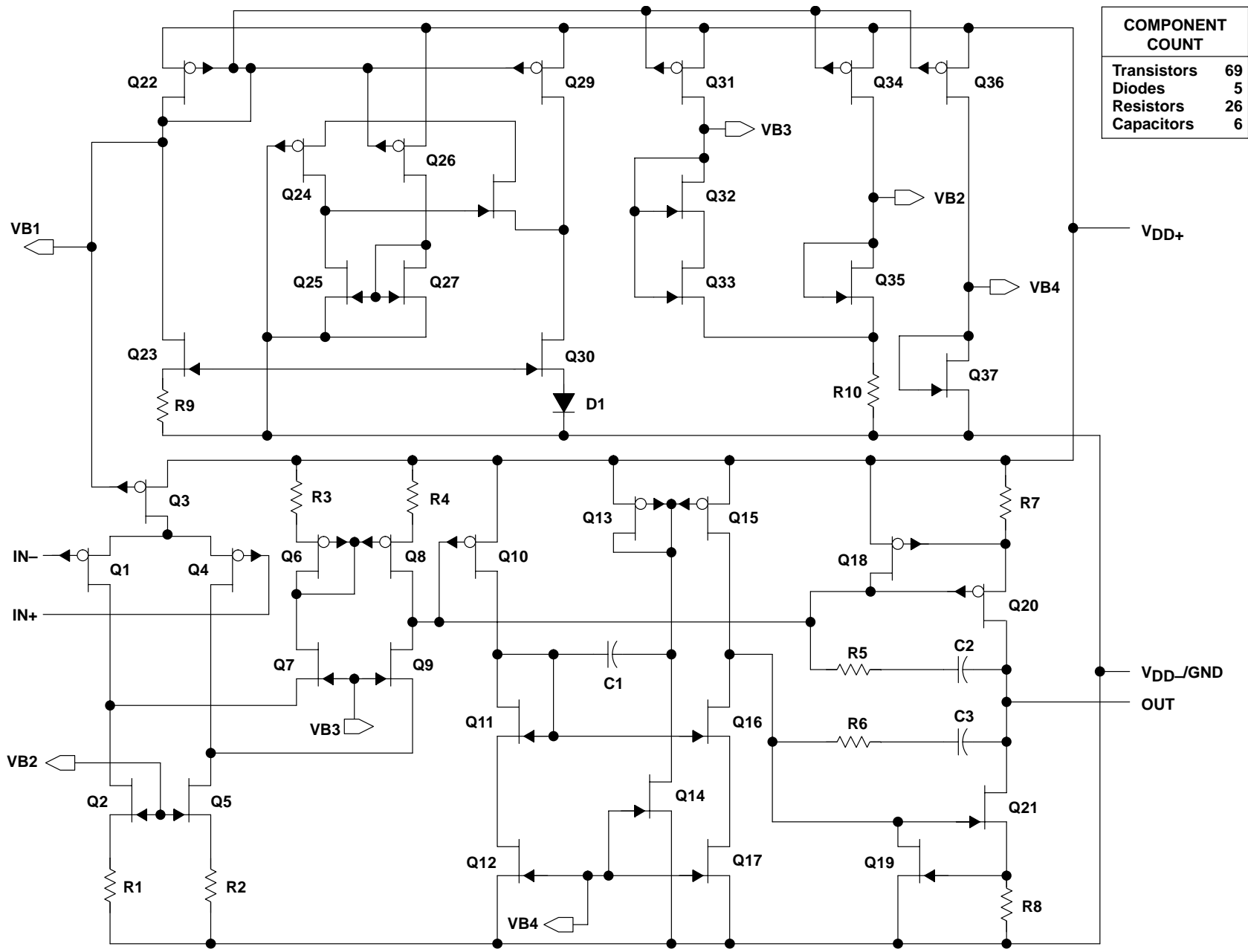
**TLV2444  
D OR PW PACKAGE  
(TOP VIEW)**



NC – No internal connection



equivalent schematic (each amplifier)



| COMPONENT COUNT |    |
|-----------------|----|
| Transistors     | 69 |
| Diodes          | 5  |
| Resistors       | 26 |
| Capacitors      | 6  |

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**absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†**

|   |                              |
|---|------------------------------|
| Supply voltage, $V_{DD}$ (see Note 1)                             | 12 V                         |
| Differential input voltage, $V_{ID}$ (see Note 2)                 | $\pm V_{DD}$                 |
| Input voltage, $V_I$ (any input, see Note 1)                      | -0.3 V to $V_{DD}$           |
| Input current, $I_I$ (any input)                                  | $\pm 5$ mA                   |
| Output current, $I_O$   | $\pm 50$ mA                  |
| Total current into $V_{DD+}$                                      | $\pm 50$ mA                  |
| Total current out of $V_{DD-}$                                    | $\pm 50$ mA                  |
| Duration of short-circuit current at (or below) 25°C (see Note 3) | unlimited                    |
| Continuous total dissipation                                      | See Dissipation Rating Table |
| Operating free-air temperature range, $T_A$ : C suffix            | 0°C to 70°C                  |
| I suffix (dual)   | -40°C to 85°C                |
| I suffix (quad)   | -40°C to 125°C               |
| Q suffix  | -40°C to 125°C               |
| M suffix  | -55°C to 125°C               |
| Storage temperature range, $T_{stg}$                              | -65°C to 150°C               |
| Lead temperature 1,6 mm (1/16 inch) from case for 10 seconds      | 260°C                        |

† Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

- NOTES: 1. All voltage values, except differential voltages, are with respect to the midpoint between  $V_{DD+}$  and  $V_{DD-}$ .  
 2. Differential voltages are at  $IN+$  with respect to  $IN-$ . Excessive current will flow if input is brought below  $V_{DD-} - 0.3$  V.  
 3. The output may be shorted to either supply. Temperature and/or supply voltages must be limited to ensure that the maximum dissipation rating is not exceeded.

**DISSIPATION RATING TABLE**

| PACKAGE | $T_A \leq 25^\circ\text{C}$<br>POWER RATING | DERATING FACTOR<br>ABOVE $T_A = 25^\circ\text{C}$ | $T_A = 70^\circ\text{C}$<br>POWER RATING | $T_A = 85^\circ\text{C}$<br>POWER RATING | $T_A = 125^\circ\text{C}$<br>POWER RATING |
|---------|---|---|--|--|---|
| D (8)   | 725 mW                                      | 5.8 mW/°C   | 464 mW                                   | 377 mW                                   | 145 mW                                    |
| D (14)  | 1022 mW                                     | 7.6 mW/°C   | 900 mW                                   | 777 mW                                   | 450 mW                                    |
| FK      | 1375 mW                                     | 11.0 mW/°C  | 880 mW                                   | 715 mW                                   | 275 mW                                    |
| JG      | 1050 mW                                     | 8.4 mW/°C   | 672 mW                                   | 546 mW                                   | 210 mW                                    |
| PW (8)  | 525 mW                                      | 4.2 mW/°C   | 336 mW                                   | 273 mW                                   | 105 mW                                    |
| PW (14) | 720 mW                                      | 5.6 mW/°C   | 634 mW                                   | 547 mW                                   | 317 mW                                    |
| U       | 675 mW                                      | 5.4 mW/°C   | 432 mW                                   | 350 mW                                   | 135 mW                                    |

**recommended operating conditions**

|                                       | C SUFFIX  |               | I SUFFIX  |               | Q SUFFIX      |                 | M SUFFIX      |                 | UNIT |
|---------------------------------------|-----------|---------------|-----------|---------------|---------------|-----------------|---------------|-----------------|------|
|                                       | MIN       | MAX           | MIN       | MAX           | MIN           | MAX             | MIN           | MAX             |      |
| Supply voltage, $V_{DD}$              | 2.7       | 10            | 2.7       | 10            | 2.7           | 10              | 2.7           | 10              | V    |
| Input voltage range, $V_I$            | $V_{DD-}$ | $V_{DD+} - 1$ | $V_{DD-}$ | $V_{DD+} - 1$ | $V_{DD-}$     | $V_{DD+} - 1.3$ | $V_{DD-}$     | $V_{DD+} - 1.3$ | V    |
| Common-mode input voltage, $V_{IC}$   | $V_{DD-}$ | $V_{DD+} - 1$ | $V_{DD-}$ | $V_{DD+} - 1$ | $V_{DD-} + 2$ | $V_{DD+} - 1.3$ | $V_{DD-} + 2$ | $V_{DD+} - 1.3$ | V    |
| Operating free-air temperature, $T_A$ | 0         | 70            | -40       | 125           | -40           | 125             | -55           | 125             | °C   |



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**electrical characteristics at specified free-air temperature,  $V_{DD} = 3\text{ V}$  (unless otherwise noted)**

| PARAMETER  | TEST CONDITIONS   | $T_A$ †                    | TLV2442    |              |                              | UNIT          |
|--|---|----------------------------|------------|--------------|------------------------------|---------------|
|  |   |                            | MIN        | TYP          | MAX                          |               |
| $V_{IO}$ Input offset voltage                                  | $V_{IC} = 1.5\text{ V}$ ,<br>$V_O = 1.5\text{ V}$ ,<br>$R_S = 50\ \Omega$ | TLV244xC<br>TLV244xI       | 25°C       | 300          | 2000                         | $\mu\text{V}$ |
|  |   |                            | Full range | 2500         |                              |               |
|  |   | TLV244xAI                  | 25°C       | 300          | 950                          |               |
|  |   |                            | Full range | 1500         |                              |               |
|  |   | TLV2442AQ<br>TLV2442AM     | 25°C       | 300          | 950                          |               |
|  |   |                            | Full range | 1600         |                              |               |
| $\alpha_{VIO}$ Temperature coefficient of input offset voltage |   | 25°C to 85°C               | 2          |              | $\mu\text{V}/^\circ\text{C}$ |               |
| Input offset voltage long-term drift (see Note 4)              |   | 25°C                       | 0.002      |              | $\mu\text{V}/\text{mo}$      |               |
| $I_{IO}$ Input offset current                                  |   | 25°C                       | 0.5        | 60           | $\text{pA}$                  |               |
|  |   | Full range                 | 150        |              |                              |               |
| $I_{IB}$ Input bias current                                    |   | 25°C                       | 1          | 60           | $\text{pA}$                  |               |
|  |   | -40°C to 85°C              | 150        |              |                              |               |
|  |   | 125°C                      | 350        |              |                              |               |
|  |   | TLV2442Q/AQ<br>TLV2442M/AM | Full range | 260          |                              |               |
| $V_{ICR}$ Common-mode input voltage range                      | $ V_{IO}  \leq 5\text{ mV}$ , $R_S = 50\ \Omega$                          | 25°C                       | 0 to 2.25  | -0.25 to 2.5 | $\text{V}$                   |               |
|  |   | Full range                 | 0 to 2     |              |                              |               |
|  |   | 25°C to -55°C              | 0 to 2.25  | -0.25 to 2.5 |                              |               |
|  |   | 125°C                      | 0 to 2     |              |                              |               |
| $V_{OH}$ High-level output voltage                             | $I_O = -100\ \mu\text{A}$   | 25°C                       | 2.98       |              | $\text{V}$                   |               |
|  |   | 25°C                       | 2.5        |              |                              |               |
|  |   | Full range                 | 2.25       |              |                              |               |
| $V_{OL}$ Low-level output voltage                              | $V_{IC} = 1.5\text{ V}$ , $I_O = 100\ \mu\text{A}$                        | 25°C                       | 0.02       |              | $\text{V}$                   |               |
|  |   | 25°C                       | 0.63       |              |                              |               |
|  |   | Full range                 | 1          |              |                              |               |
| $A_{VD}$ Large-signal differential voltage amplification       | $V_O = 1\text{ V to }2\text{ V}$  | $R_L = 600\ \Omega$        | 25°C       | 0.7          | 1                            | $\text{V/mV}$ |
|  |   |                            | Full range | 0.4          |                              |               |
|  |   | $R_L = 1\ \text{M}\Omega$  | 25°C       | 750          |                              |               |
| $r_{id}$ Differential input resistance                         |   | 25°C                       | 1000       |              | $\text{G}\Omega$             |               |
| $r_i$ Common-mode input resistance                             |   | 25°C                       | 1000       |              | $\text{G}\Omega$             |               |
| $c_i$ Common-mode input capacitance                            | $f = 10\ \text{kHz}$  | 25°C                       | 8          |              | $\text{pF}$                  |               |
| $z_o$ Closed-loop output impedance                             | $f = 1\ \text{MHz}$ , $A_V = 10$  | 25°C                       | 130        |              | $\Omega$                     |               |

† Full range for the C suffix is 0°C to 70°C. Full range for the dual I suffix is -40°C to 85°C. Full range for the quad I suffix is -40°C to 125°C. Full range for the Q suffix is -40°C to 125°C. Full range for the M suffix is -55°C to 125°C.

NOTE 4: Typical values are based on the input offset voltage shift observed through 168 hours of operating life test at  $T_A = 150^\circ\text{C}$  extrapolated to  $T_A = 25^\circ\text{C}$  using the Arrhenius equation and assuming an activation energy of 0.96 eV.



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**electrical characteristics at specified free-air temperature,  $V_{DD} = 3\text{ V}$  (unless otherwise noted) (continued)**

| PARAMETER   | TEST CONDITIONS  | $T_A$ †    | TLV2442 |      |               | UNIT |
|---|--|------------|---------|------|---------------|------|
|   |  |            | MIN     | TYP  | MAX           |      |
| CMRR Common-mode rejection ratio  | $V_{IC} = 0\text{ to }2.25\text{ V}$ ,<br>$V_O = 1.5\text{ V}$ ,<br>$R_S = 50\ \Omega$ | 25°C       | 65      | 75   | dB            |      |
|   |  | Full range | 55      |      |               |      |
|   |  | Full range | 50      |      |               |      |
| $k_{SVR}$ Supply-voltage rejection ratio ( $\Delta V_{DD\pm}/\Delta V_{IO}$ ) | $V_{DD} = 2.7\text{ V to }8\text{ V}$ ,<br>No load<br>$V_{IC} = V_{DD}/2$ ,            | 25°C       | 80      | 95   | dB            |      |
|   |  | Full range | 80      |      |               |      |
| $I_{DD}$ Supply current (per channel)   | $V_O = 1.5\text{ V}$ ,<br>No load  | 25°C       | 725     | 1100 | $\mu\text{A}$ |      |
|   |  | Full range | 1100    |      |               |      |

† Full range for the C suffix is 0°C to 70°C. Full range for the dual I suffix is –40°C to 85°C. Full range for the quad I suffix is –40°C to 125°C. Full range for the Q suffix is –40°C to 125°C. Full range for the M suffix is –55°C to 125°C.

**operating characteristics at specified free-air temperature,  $V_{DD} = 3\text{ V}$**

| PARAMETER   | TEST CONDITIONS   | $T_A$ †    | TLV244x     |       |                              | UNIT |
|---|---|------------|-------------|-------|------------------------------|------|
|   |   |            | MIN         | TYP   | MAX                          |      |
| SR Slew rate at unity gain                              | $V_O = 1\text{ V to }2\text{ V}$ ,<br>$R_L = 600\ \Omega$ ,<br>$C_L = 100\text{ pF}$      | 25°C       | 0.65        | 1.3   | $\text{V}/\mu\text{s}$       |      |
|   |   | Full range | 0.65        |       |                              |      |
|   |   | Full range | 0.4         |       |                              |      |
| $V_n$ Equivalent input noise voltage                    | $f = 10\text{ Hz}$  | 25°C       | 170         |       | $\text{nV}/\sqrt{\text{Hz}}$ |      |
|   | $f = 1\text{ kHz}$  | 25°C       | 18          |       |                              |      |
| $V_{N(PP)}$ Peak-to-peak equivalent input noise voltage | $f = 0.1\text{ Hz to }1\text{ Hz}$  | 25°C       | 2.6         |       | $\mu\text{V}$                |      |
|   | $f = 0.1\text{ Hz to }10\text{ Hz}$   | 25°C       | 5.1         |       |                              |      |
| $I_n$ Equivalent input noise current                    |   | 25°C       | 0.6         |       | $\text{fA}/\sqrt{\text{Hz}}$ |      |
| THD + N Total harmonic distortion plus noise            | $V_O = 0.5\text{ V to }2.5\text{ V}$ ,<br>$R_L = 600\ \Omega$ ,<br>$f = 1\text{ kHz}$     | 25°C       | $A_V = 1$   | 0.08% |                              |      |
|   |   |            | $A_V = 10$  | 0.3%  |                              |      |
|   |   |            | $A_V = 100$ | 2%    |                              |      |
| Gain-bandwidth product                                  | $f = 10\text{ kHz}$ ,<br>$C_L = 100\text{ pF}$  | 25°C       | 1.75        |       | MHz                          |      |
| BOM Maximum output-swing bandwidth                      | $V_{O(PP)} = 1\text{ V}$ ,<br>$A_V = 1$ ,   | 25°C       | 0.9         |       | MHz                          |      |
| $t_s$ Settling time                                     | $A_V = -1$ ,<br>Step = –2.3 V to 2.3 V,<br>$R_L = 600\ \Omega$ ,<br>$C_L = 100\text{ pF}$ | 25°C       | To 0.1%     | 1.5   |                              |      |
|   |   |            | To 0.01%    | 3.2   |                              |      |
| $\phi_m$ Phase margin at unity gain                     | $R_L = 600\ \Omega$ ,<br>$C_L = 100\text{ pF}$  | 25°C       | 65°         |       |                              |      |
| Gain margin   |   | 25°C       | 9           |       | dB                           |      |

† Full range for the C suffix is 0°C to 70°C. Full range for the dual I suffix is –40°C to 85°C. Full range for the quad I suffix is –40°C to 125°C. Full range for the Q suffix is –40°C to 125°C. Full range for the M suffix is –55°C to 125°C.



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**electrical characteristics at specified free-air temperature,  $V_{DD} = 5\text{ V}$  (unless otherwise noted)**

| PARAMETER  | TEST CONDITIONS   | $T_A$ †                    | TLV244x    |              |                              | UNIT          |
|--|---|----------------------------|------------|--------------|------------------------------|---------------|
|  |   |                            | MIN        | TYP          | MAX                          |               |
| $V_{IO}$ Input offset voltage                                  | $V_{DD\pm} = \pm 2.5\text{ V}$ ,<br>$V_O = 0$ ,<br>$V_{IC} = 0$ ,<br>$R_S = 50\ \Omega$ | TLV244xC<br>TLV244xI       | 25°C       | 300          | 2000                         | $\mu\text{V}$ |
|  |   |                            | Full range |              | 2500                         |               |
|  |   | TLV244xA                   | 25°C       | 300          | 950                          |               |
|  |   |                            | Full range |              | 1500                         |               |
|  |   | TLV2442AQ<br>TLV2442AM     | 25°C       | 300          | 950                          |               |
|  |   |                            | Full range |              | 1600                         |               |
| $\alpha_{VIO}$ Temperature coefficient of input offset voltage |   | 25°C to 85°C               | 2          |              | $\mu\text{V}/^\circ\text{C}$ |               |
| Input offset voltage long-term drift (see Note 4)              |   | 25°C                       | 0.002      |              | $\mu\text{V}/\text{mo}$      |               |
| $I_{IO}$ Input offset current                                  |   | 25°C                       | 0.5        | 60           | $\text{pA}$                  |               |
|  |   | Full range                 |            | 150          |                              |               |
| $I_{IB}$ Input bias current                                    |   | 25°C                       | 1          | 60           | $\text{pA}$                  |               |
|  |   | -40°C to 85°C              |            | 150          |                              |               |
|  |   | 125°C                      |            | 350          |                              |               |
|  |   | TLV2442Q/AQ<br>TLV2442M/AM | Full range |              |                              | 260           |
| $V_{ICR}$ Common-mode input voltage range                      | $ V_{IO}  \leq 5\text{ mV}$ ,<br>$R_S = 50\ \Omega$                                     | 25°C                       | 0 to 4.25  | -0.25 to 4.5 | V                            |               |
|  |   | Full range                 | 0 to 4     |              |                              |               |
| $V_{OH}$ High-level output voltage                             | $I_{OH} = -100\ \mu\text{A}$  | 25°C                       | 4.97       |              | V                            |               |
|  | $I_{OH} = -5\text{ mA}$   | 25°C                       | 4          | 4.35         |                              |               |
|  |   | Full range                 | 4          |              |                              |               |
| $V_{OL}$ Low-level output voltage                              | $V_{IC} = 2.5\text{ V}$ ,<br>$I_{OL} = 100\ \mu\text{A}$                                | 25°C                       | 0.01       |              | V                            |               |
|  | $V_{IC} = 2.5\text{ V}$ ,<br>$I_{OL} = 5\text{ mA}$                                     | 25°C                       | 0.8        |              |                              |               |
|  |   | Full range                 | 1.25       |              |                              |               |
| $A_{VD}$ Large-signal differential voltage amplification       | $V_{IC} = 2.5\text{ V}$ ,<br>$V_O = 1\text{ V to }4\text{ V}$                           | $R_L = 600\ \Omega$ ‡      | 25°C       | 0.9          | 1.3                          | V/mV          |
|  |   |                            | Full range | 0.5          |                              |               |
|  |   | $R_L = 1\text{ M}\Omega$ ‡ | 25°C       | 950          |                              |               |
| $r_{id}$ Differential input resistance                         |   | 25°C                       | 1000       |              | $\text{G}\Omega$             |               |
| $r_i$ Common-mode input resistance                             |   | 25°C                       | 1000       |              | $\text{G}\Omega$             |               |
| $c_i$ Common-mode input capacitance                            | $f = 10\text{ kHz}$   | 25°C                       | 8          |              | $\text{pF}$                  |               |
| $z_o$ Closed-loop output impedance                             | $f = 1\text{ MHz}$ ,<br>$A_V = 10$  | 25°C                       | 140        |              | $\Omega$                     |               |
| CMRR Common-mode rejection ratio                               | $V_{IC} = 0\text{ to }4.25\text{ V}$ ,<br>$V_O = 2.5\text{ V}$ ,<br>$R_S = 50\ \Omega$  | 25°C                       | 70         | 75           | dB                           |               |
|  |   | Full range                 | 70         |              |                              |               |

† Full range for the C suffix is 0°C to 70°C. Full range for the dual I suffix is -40°C to 85°C. Full range for the quad I suffix is -40°C to 125°C. Full range for the Q suffix is -40°C to 125°C. Full range for the M suffix is -55°C to 125°C.

‡ Referenced to 2.5 V

NOTE 4: Typical values are based on the input offset voltage shift observed through 168 hours of operating life test at  $T_A = 150^\circ\text{C}$  extrapolated to  $T_A = 25^\circ\text{C}$  using the Arrhenius equation and assuming an activation energy of 0.96 eV.

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**electrical characteristics at specified free-air temperature,  $V_{DD} = 5\text{ V}$  (unless otherwise noted) (continued)**

| PARAMETER  | TEST CONDITIONS  | $T_A$ †    | TLV244x |      |     | UNIT          |
|--|--|------------|---------|------|-----|---------------|
|  |  |            | MIN     | TYP  | MAX |               |
| $k_{SVR}$ Supply-voltage rejection ratio ( $\Delta V_{DD}/\Delta V_{IO}$ ) | $V_{DD} = 4.4\text{ V to }8\text{ V}$ ,<br>$V_{IC} = V_{DD}/2$ , No load | 25°C       | 80      | 95   |     | dB            |
|  |  | Full range | 80      |      |     |               |
| $I_{DD}$ Supply current (per channel)                                      | $V_O = 2.5\text{ V}$ , No load   | 25°C       | 750     | 1100 |     | $\mu\text{A}$ |
|  |  | Full range |         | 1100 |     |               |

† Full range for the C suffix is 0°C to 70°C. Full range for the dual I suffix is –40°C to 85°C. Full range for the quad I suffix is –40°C to 125°C. Full range for the Q suffix is –40°C to 125°C. Full range for the M suffix is –55°C to 125°C.

**operating characteristics at specified free-air temperature,  $V_{DD} = 5\text{ V}$**

| PARAMETER   | TEST CONDITIONS   | $T_A$ †                    | TLV244x     |        |     | UNIT                         |
|---|---|----------------------------|-------------|--------|-----|------------------------------|
|   |   |                            | MIN         | TYP    | MAX |                              |
| SR Slew rate at unity gain                              | $V_O = 0.5\text{ V to }2.5\text{ V}$ ,<br>$R_L = 600\ \Omega$ ‡,<br>$C_L = 100\text{ pF}$ ‡ | 25°C                       | 0.75        | 1.4    |     | $\text{V}/\mu\text{s}$       |
|   |   | Full range                 | 0.75        |        |     |                              |
|   |   | TLV2442Q/AQ<br>TLV2442M/AM | Full range  | 0.5    |     |                              |
| $V_n$ Equivalent input noise voltage                    | $f = 10\text{ Hz}$  | 25°C                       |             | 130    |     | $\text{nV}/\sqrt{\text{Hz}}$ |
|   | $f = 1\text{ kHz}$  | 25°C                       |             | 16     |     |                              |
| $V_{N(PP)}$ Peak-to-peak equivalent input noise voltage | $f = 0.1\text{ Hz to }1\text{ Hz}$  | 25°C                       |             | 1.8    |     | $\mu\text{V}$                |
|   | $f = 0.1\text{ Hz to }10\text{ Hz}$   | 25°C                       |             | 3.6    |     |                              |
| $I_n$ Equivalent input noise current                    |   | 25°C                       |             | 0.6    |     | $\text{fA}/\sqrt{\text{Hz}}$ |
| THD + N Total harmonic distortion plus noise            | $V_O = 1.5\text{ V to }3.5\text{ V}$ ,<br>$f = 1\text{ kHz}$ ,<br>$R_L = 600\ \Omega$ ‡     | 25°C                       | $A_V = 1$   | 0.017% |     |                              |
|   |   |                            | $A_V = 10$  | 0.17%  |     |                              |
|   |   |                            | $A_V = 100$ | 1.5%   |     |                              |
| Gain-bandwidth product                                  | $f = 10\text{ kHz}$ ,<br>$C_L = 100\text{ pF}$ ‡, $R_L = 600\ \Omega$ ‡                     | 25°C                       |             | 1.81   |     | MHz                          |
| BOM Maximum output-swing bandwidth                      | $V_{O(PP)} = 2\text{ V}$ , $A_V = 1$ ,<br>$R_L = 600\ \Omega$ ‡, $C_L = 100\text{ pF}$ ‡    | 25°C                       |             | 0.5    |     | MHz                          |
| $t_s$ Settling time                                     | $A_V = -1$ ,<br>Step = 0.5 V to 2.5 V,<br>$R_L = 600\ \Omega$ ‡,<br>$C_L = 100\text{ pF}$ ‡ | 25°C                       | To 0.1%     | 1.5    |     | $\mu\text{s}$                |
|   |   |                            | To 0.01%    | 2.6    |     |                              |
| $\phi_m$ Phase margin at unity gain                     | $R_L = 600\ \Omega$ ‡, $C_L = 100\text{ pF}$ ‡  | 25°C                       |             | 68°    |     |                              |
| Gain margin   |   | 25°C                       |             | 8      |     | dB                           |

† Full range for the C suffix is 0°C to 70°C. Full range for the dual I suffix is –40°C to 85°C. Full range for the quad I suffix is –40°C to 125°C. Full range for the Q suffix is –40°C to 125°C. Full range for the M suffix is –55°C to 125°C.

‡ Referenced to 2.5 V





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**TYPICAL CHARACTERISTICS**

**Table of Graphs†**

|                 |  |  | FIGURE       |
|-----------------|--|--|--------------|
| $V_{IO}$        | Input offset voltage   | Distribution<br>vs Common-mode input voltage | 2, 3<br>4, 5 |
| $\alpha V_{IO}$ | Input offset voltage temperature coefficient                     | Distribution                                 | 6, 7         |
| $I_{IB}/I_{IO}$ | Input bias and input offset currents                             | vs Free-air temperature                      | 8            |
| $V_{OH}$        | High-level output voltage  | vs High-level output current                 | 9, 10        |
| $V_{OL}$        | Low-level output voltage   | vs Low-level output current                  | 11, 12       |
| $V_{O(PP)}$     | Maximum peak-to-peak output voltage                              | vs Frequency                                 | 13           |
| $I_{OS}$        | Short-circuit output current                                     | vs Supply voltage<br>vs Free-air temperature | 14<br>15     |
| $V_O$           | Output voltage   | vs Differential Input voltage                | 16, 17       |
| $A_{VD}$        | Differential voltage amplification                               | vs Load resistance                           | 18           |
| $A_{VD}$        | Large-signal differential voltage amplification and phase margin | vs Frequency                                 | 19, 20       |
|                 | Large-signal differential voltage amplification                  | vs Free-air temperature                      | 21, 22       |
| $z_o$           | Output impedance   | vs Frequency                                 | 23, 24       |
| CMRR            | Common-mode rejection ratio                                      | vs Frequency                                 | 25           |
|                 |  | vs Free-air temperature                      | 26           |
| $k_{SVR}$       | Supply-voltage rejection ratio                                   | vs Frequency                                 | 27, 28       |
|                 |  | vs Free-air temperature                      | 29           |
| $I_{DD}$        | Supply current   | vs Supply voltage                            | 30           |
| SR              | Slew rate  | vs Load capacitance                          | 31           |
|                 |  | vs Free-air temperature                      | 32           |
| $V_O$           | Inverting large-signal pulse response                            |  | 33, 34       |
|                 | Voltage-follower large-signal pulse response                     |  | 35, 36       |
|                 | Inverting small-signal pulse response                            |  | 37, 38       |
|                 | Voltage-follower small-signal pulse response                     |  | 39, 40       |
| $V_n$           | Equivalent input noise voltage                                   | vs Frequency                                 | 41, 42       |
|                 | Noise voltage  | Over a 10-second period                      | 43           |
| THD + N         | Total harmonic distortion plus noise                             | vs Frequency                                 | 44, 45       |
|                 | Gain-bandwidth product   | vs Free-air temperature                      | 46           |
|                 |  | vs Supply voltage                            | 47           |
| $\phi_m$        | Phase margin   | vs Frequency<br>vs Load capacitance          | 19, 20<br>48 |
|                 | Gain margin  | vs Load capacitance                          | 49           |
| $B_1$           | Unity-gain bandwidth   | vs Load capacitance                          | 50           |

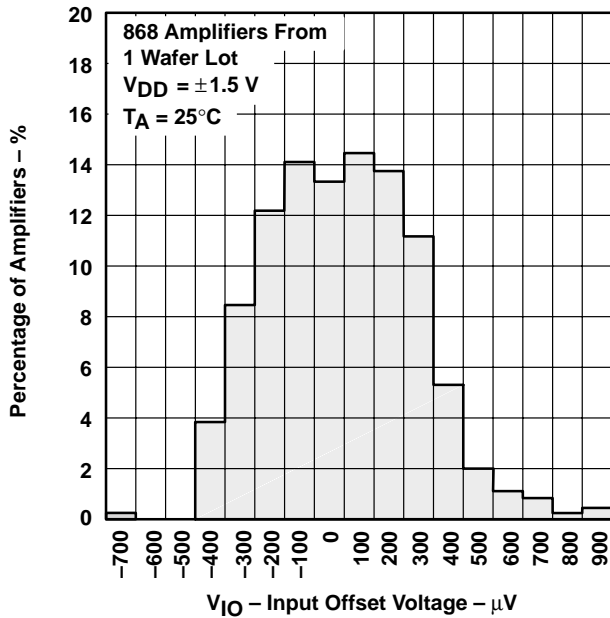
† For all graphs where  $V_{DD} = 5$  V, all loads are referenced to 2.5 V.

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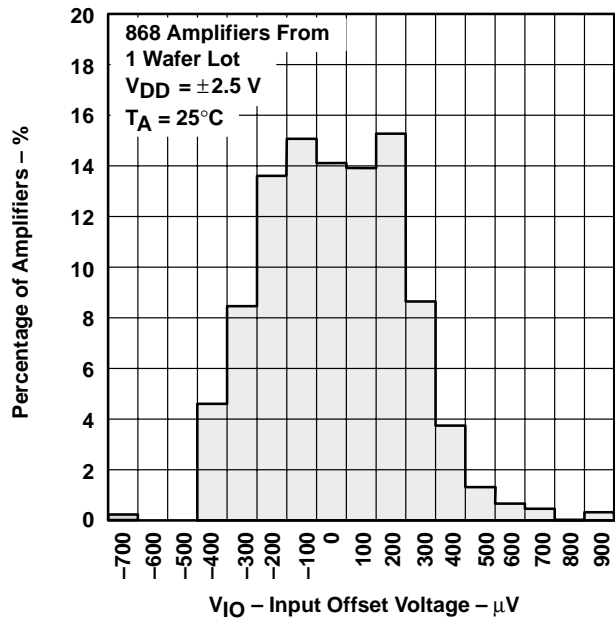
**TYPICAL CHARACTERISTICS**

**DISTRIBUTION OF TLV2442  
 INPUT OFFSET VOLTAGE**



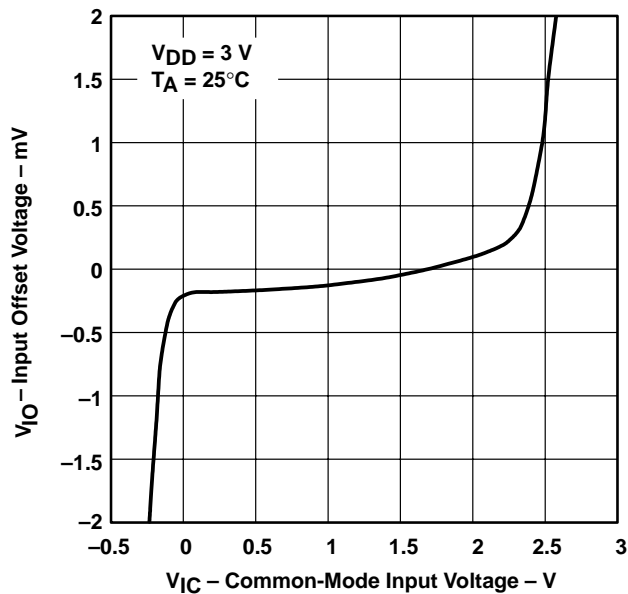
**Figure 2**

**DISTRIBUTION OF TLV2442  
 INPUT OFFSET VOLTAGE**



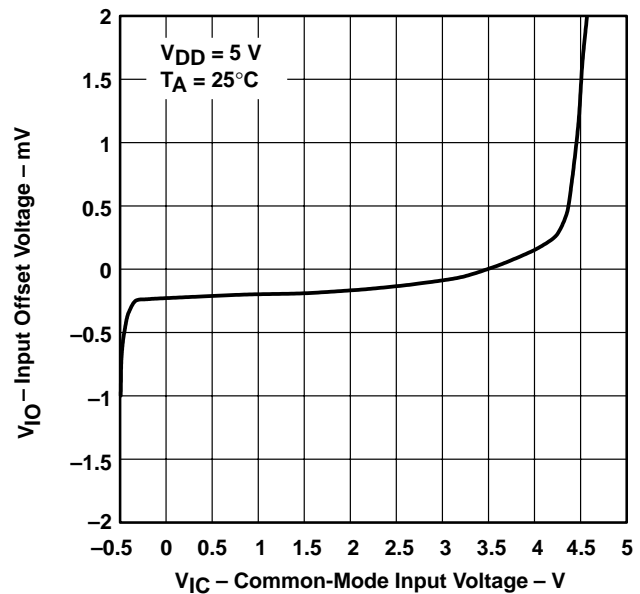
**Figure 3**

**INPUT OFFSET VOLTAGE  
 vs  
 COMMON-MODE INPUT VOLTAGE**



**Figure 4**

**INPUT OFFSET VOLTAGE  
 vs  
 COMMON-MODE INPUT VOLTAGE**



**Figure 5**



TYPICAL CHARACTERISTICS

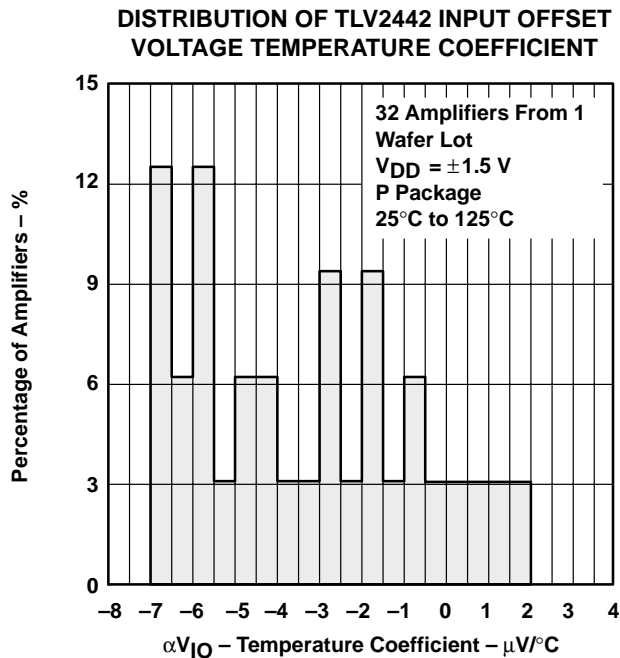


Figure 6

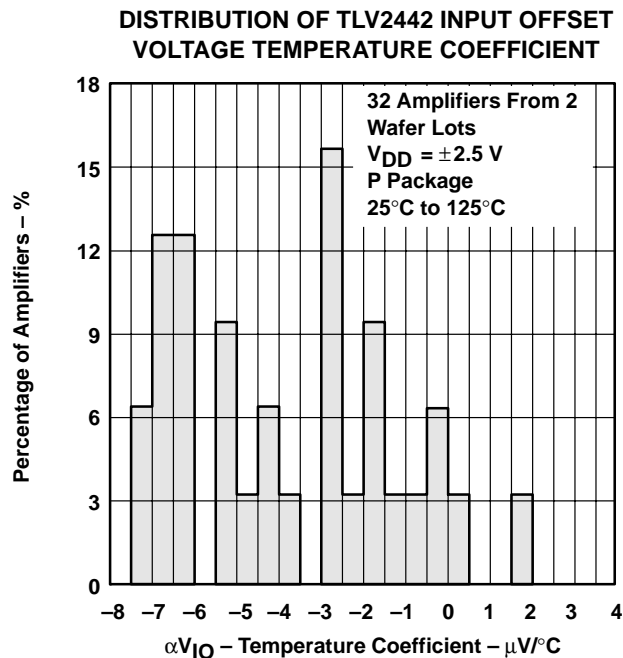


Figure 7

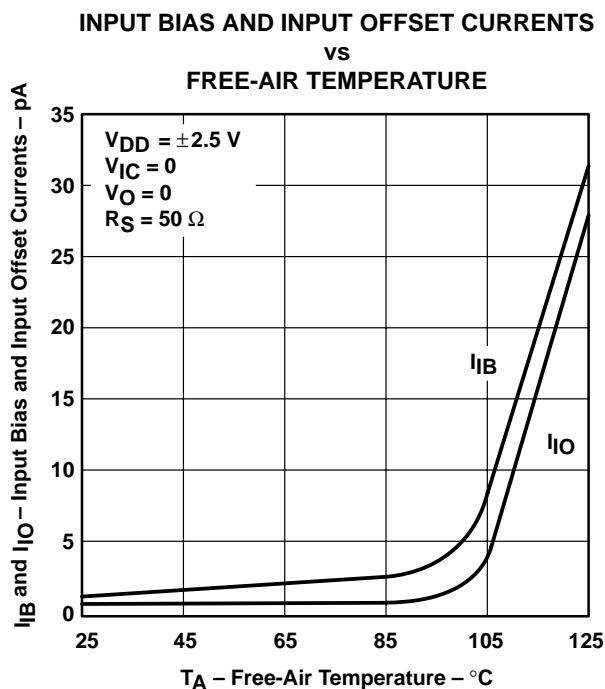


Figure 8

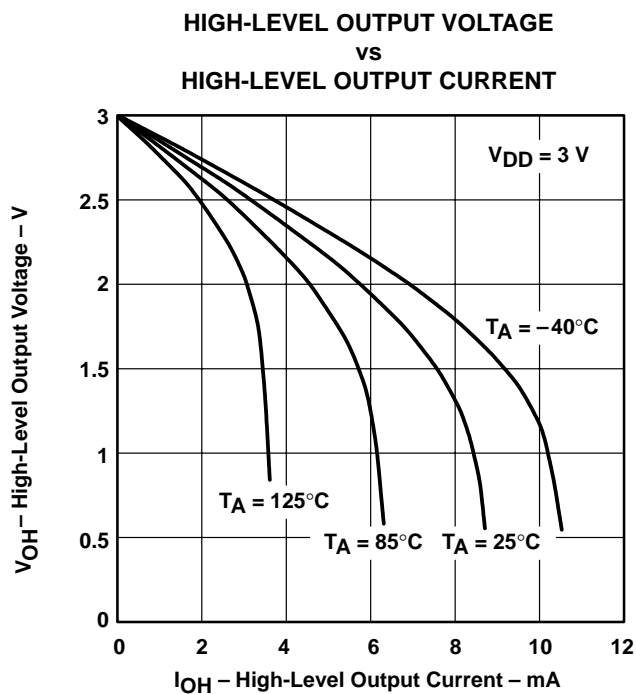


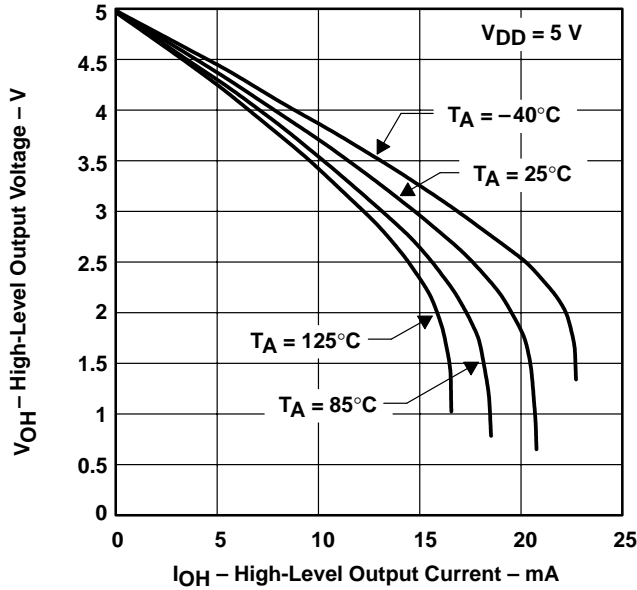
Figure 9

**TLV2442, TLV2442A, TLV2444, TLV2444A**  
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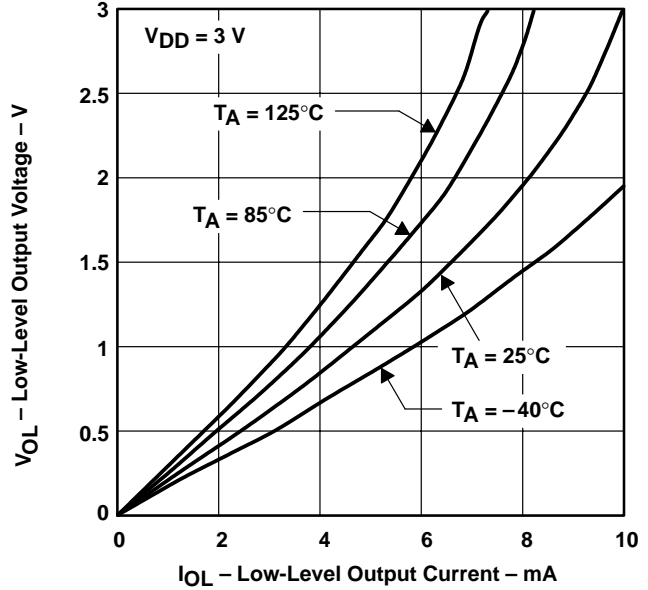
**TYPICAL CHARACTERISTICS**

**HIGH-LEVEL OUTPUT VOLTAGE  
vs  
HIGH-LEVEL OUTPUT CURRENT**



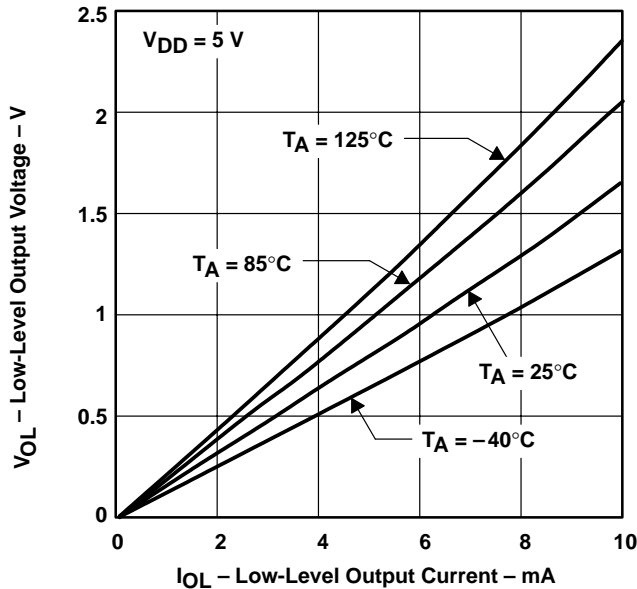
**Figure 10**

**LOW-LEVEL OUTPUT VOLTAGE  
vs  
LOW-LEVEL OUTPUT CURRENT**



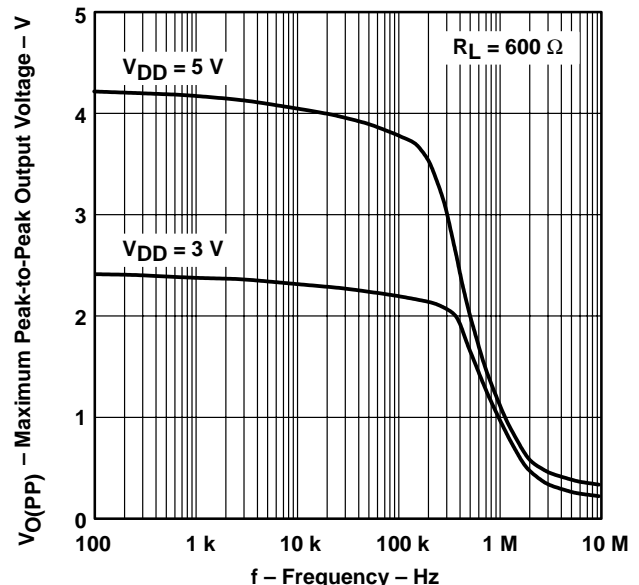
**Figure 11**

**LOW-LEVEL OUTPUT VOLTAGE  
vs  
LOW-LEVEL OUTPUT CURRENT**



**Figure 12**

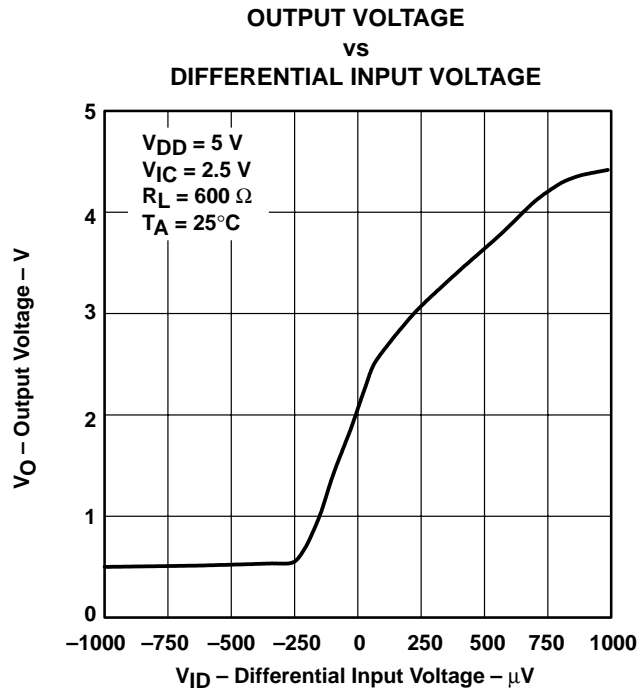
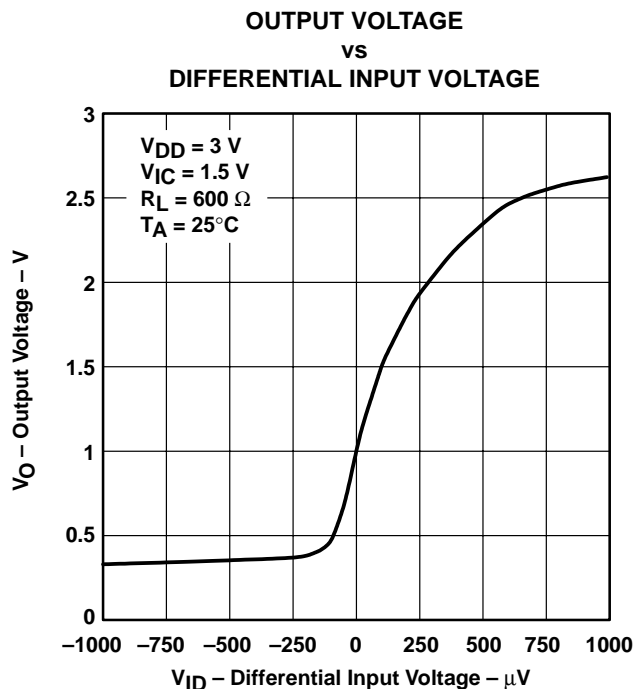
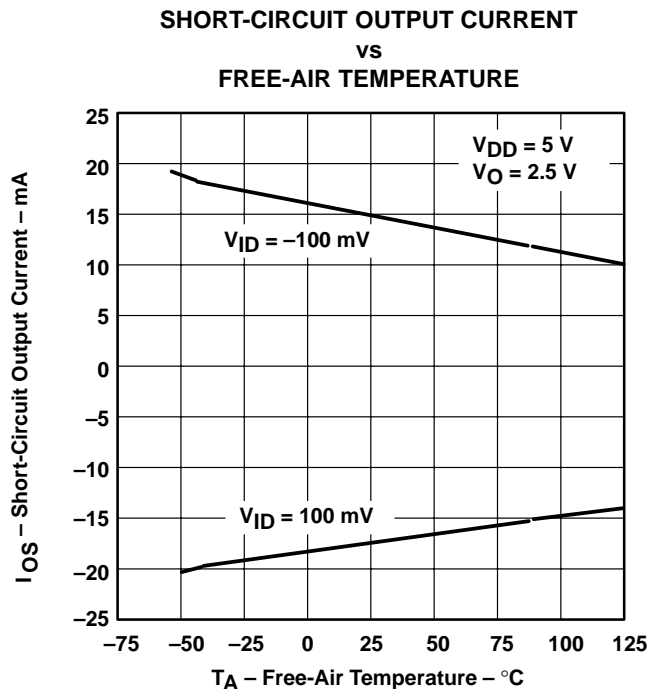
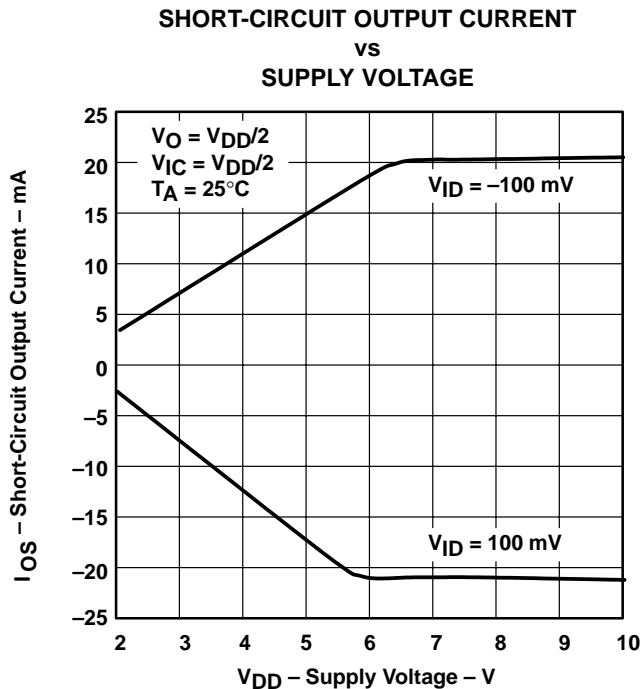
**MAXIMUM PEAK-TO-PEAK OUTPUT VOLTAGE  
vs  
FREQUENCY**



**Figure 13**



TYPICAL CHARACTERISTICS

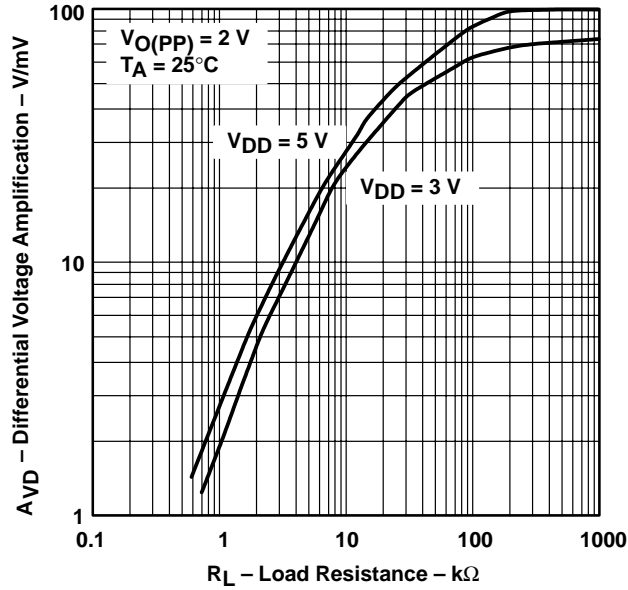


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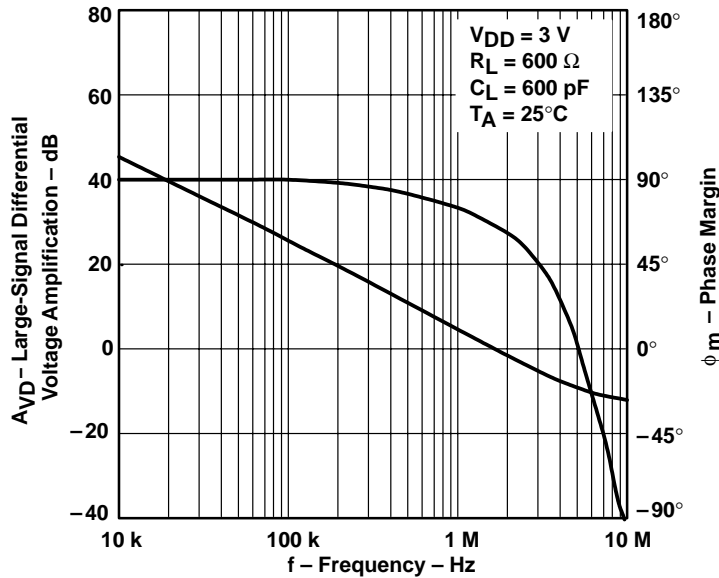
**TYPICAL CHARACTERISTICS**

**DIFFERENTIAL VOLTAGE AMPLIFICATION**  
**vs**  
**LOAD RESISTANCE**



**Figure 18**

**LARGE-SIGNAL DIFFERENTIAL VOLTAGE**  
**AMPLIFICATION AND PHASE MARGIN**  
**vs**  
**FREQUENCY**



**Figure 19**



TYPICAL CHARACTERISTICS

LARGE-SIGNAL DIFFERENTIAL VOLTAGE  
 AMPLIFICATION AND PHASE MARGIN  
 vs  
 FREQUENCY

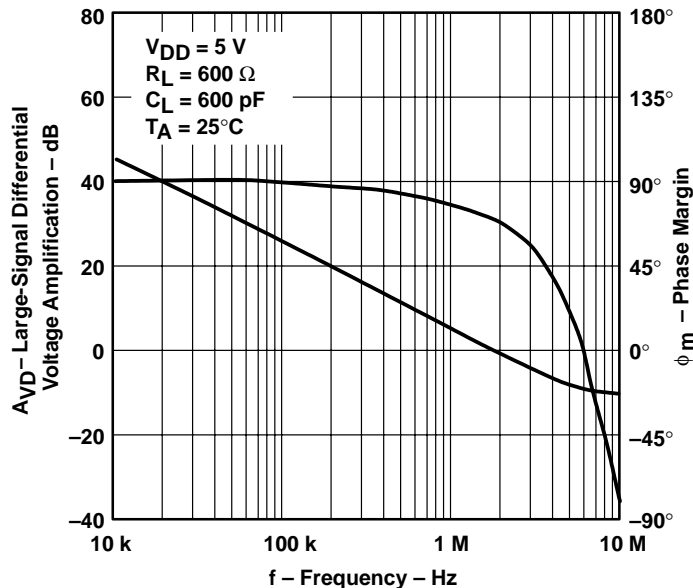


Figure 20

LARGE-SIGNAL DIFFERENTIAL  
 VOLTAGE AMPLIFICATION  
 vs  
 FREE-AIR TEMPERATURE

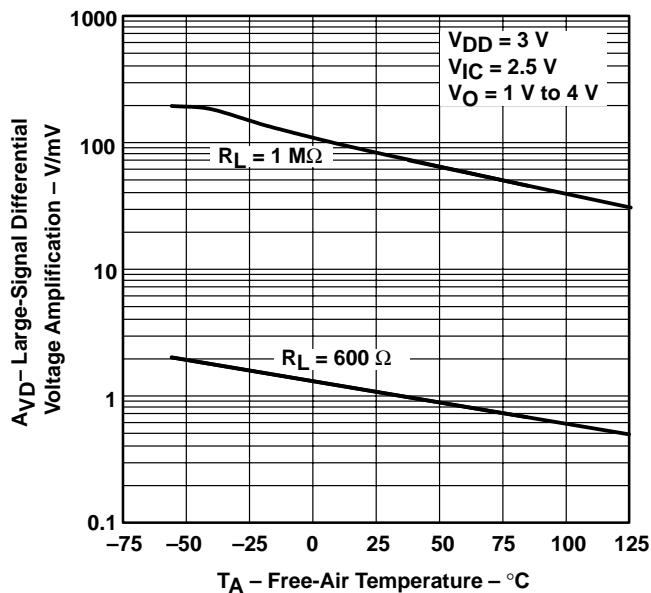


Figure 21

LARGE-SIGNAL DIFFERENTIAL  
 VOLTAGE AMPLIFICATION  
 vs  
 FREE-AIR TEMPERATURE

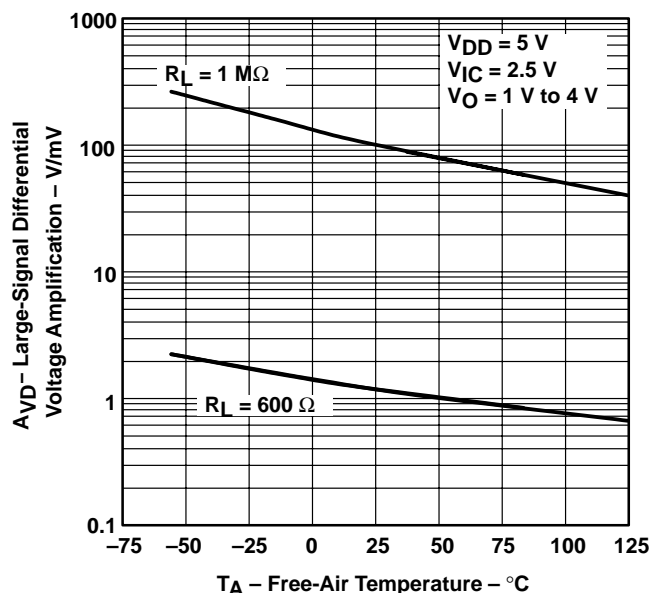


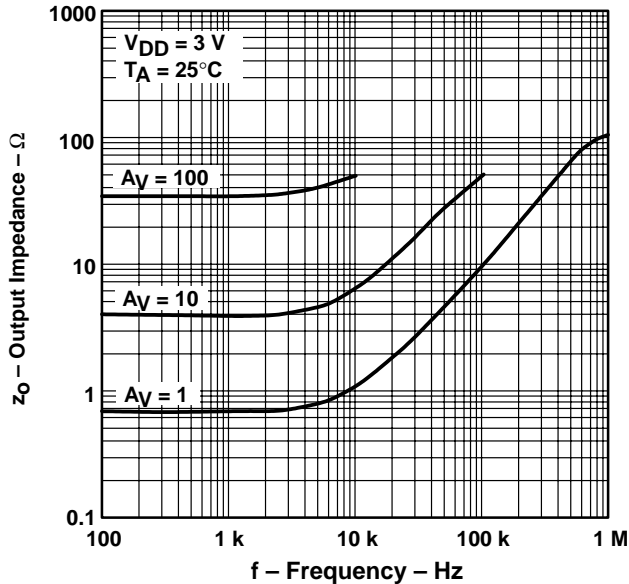
Figure 22

**TLV2442, TLV2442A, TLV2444, TLV2444A**  
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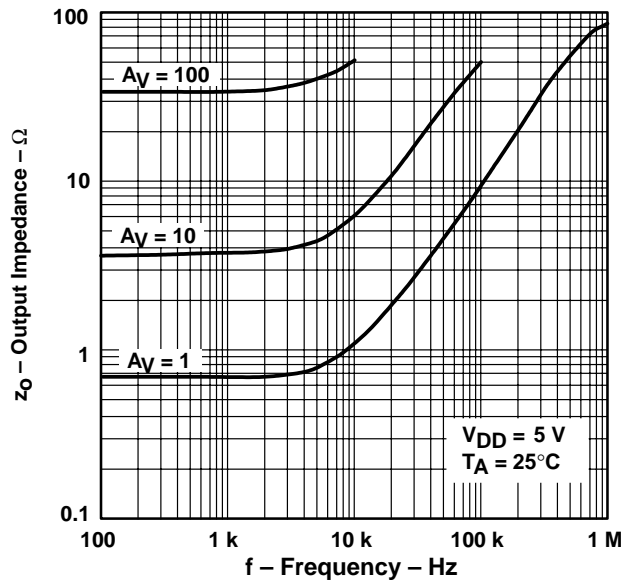
**TYPICAL CHARACTERISTICS**

**OUTPUT IMPEDANCE  
vs  
FREQUENCY**



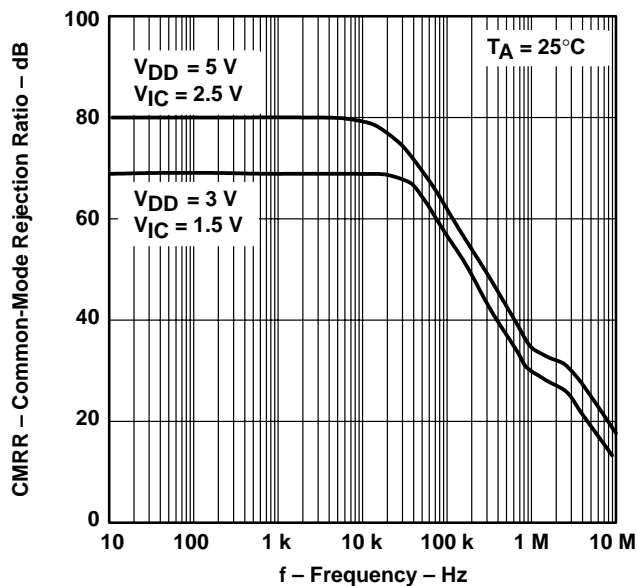
**Figure 23**

**OUTPUT IMPEDANCE  
vs  
FREQUENCY**



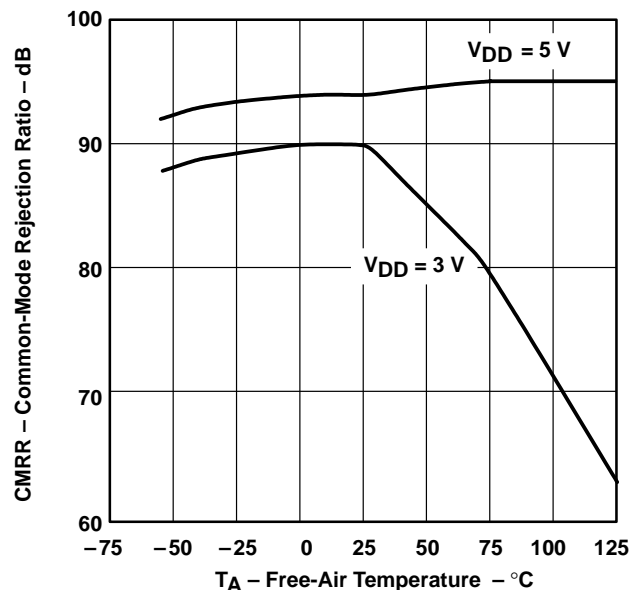
**Figure 24**

**COMMON-MODE REJECTION RATIO  
vs  
FREQUENCY**



**Figure 25**

**COMMON-MODE REJECTION RATIO  
vs  
FREE-AIR TEMPERATURE**



**Figure 26**





TYPICAL CHARACTERISTICS

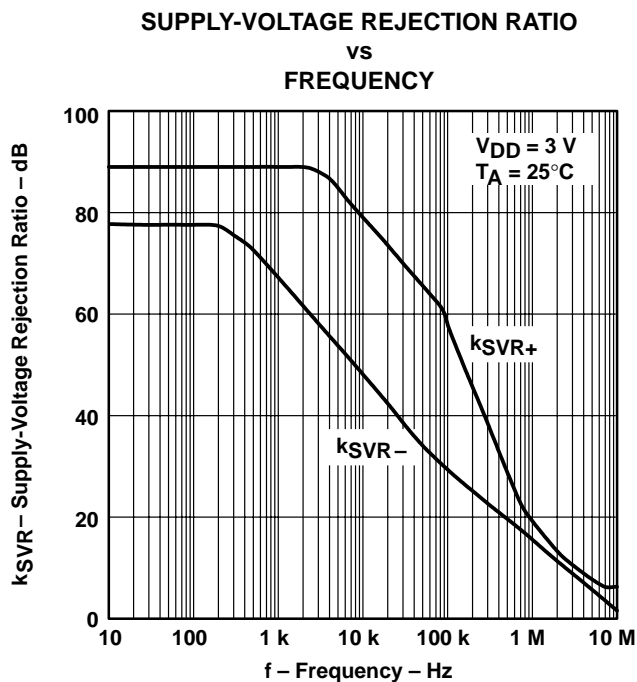


Figure 27

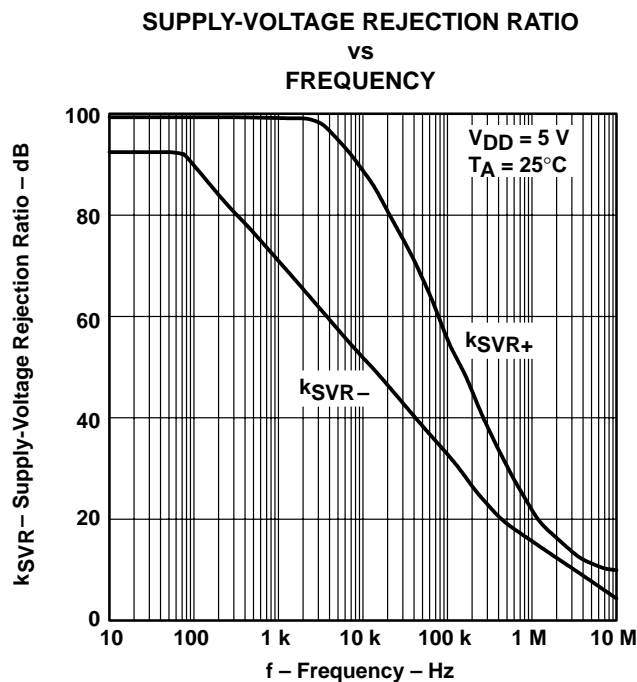


Figure 28

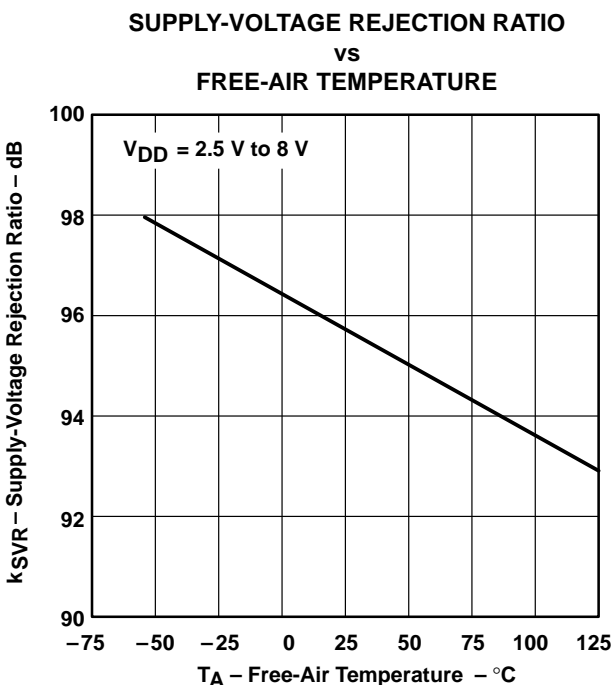


Figure 29

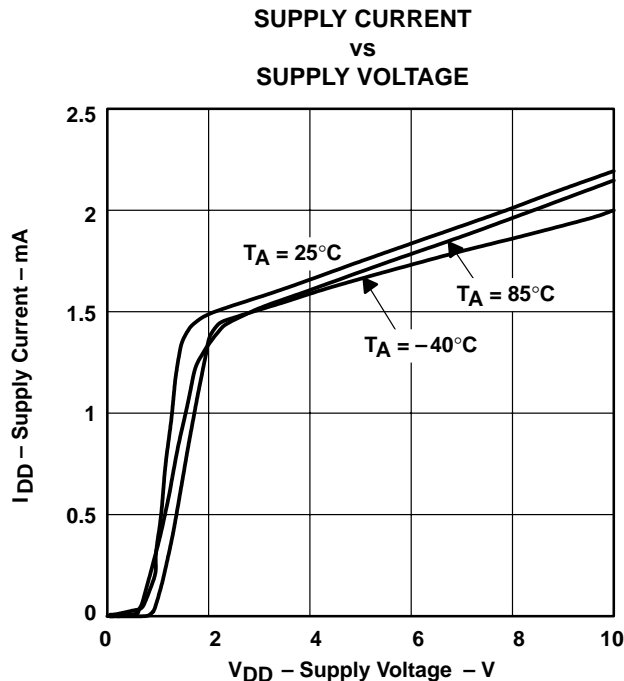


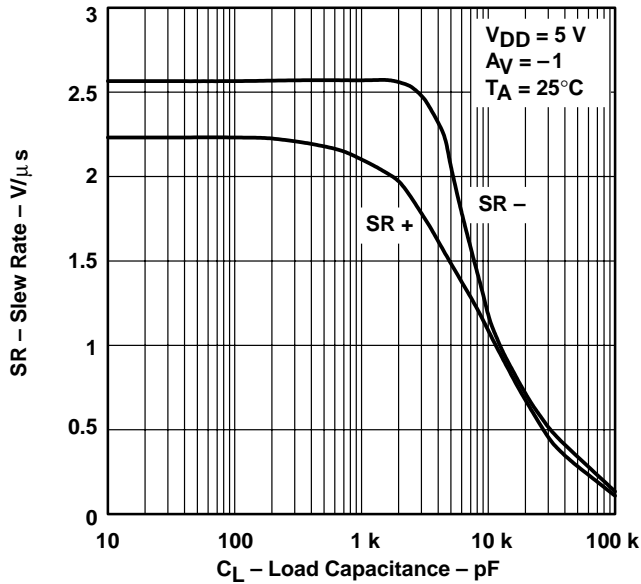
Figure 30

**TLV2442, TLV2442A, TLV2444, TLV2444A**  
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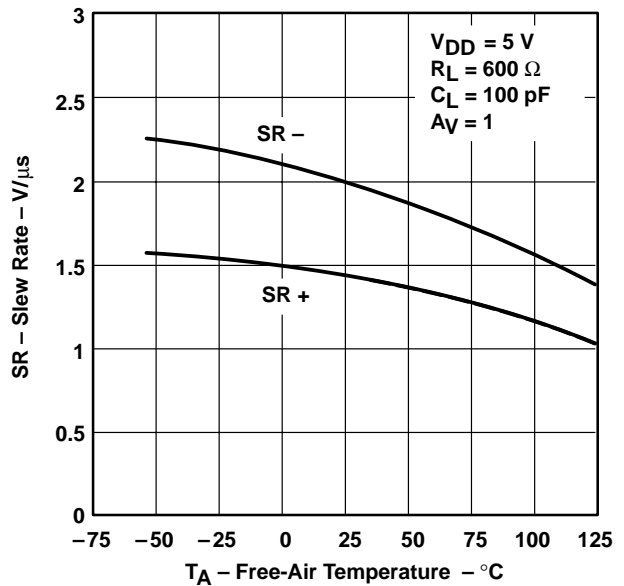
**TYPICAL CHARACTERISTICS**

**SLEW RATE  
vs  
LOAD CAPACITANCE**



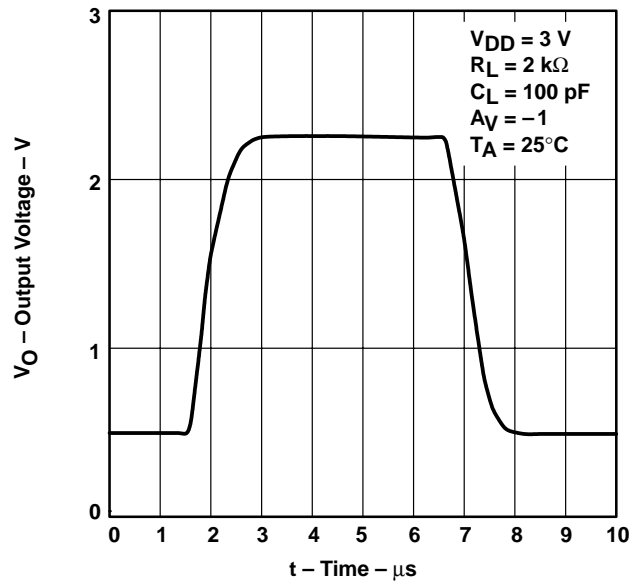
**Figure 31**

**SLEW RATE  
vs  
FREE-AIR TEMPERATURE**



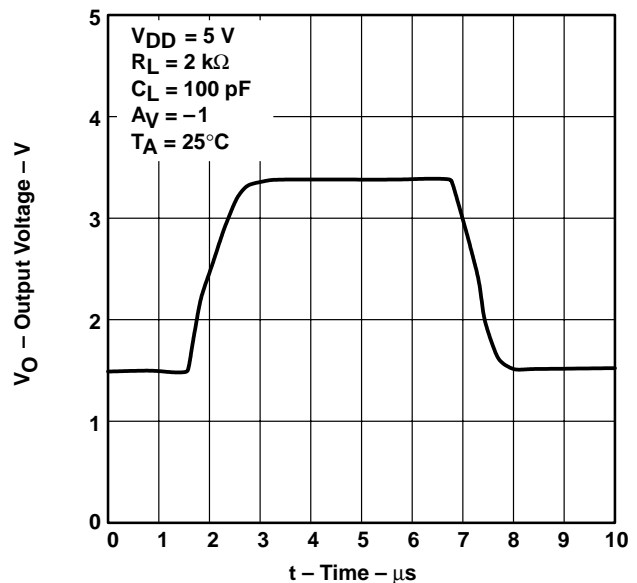
**Figure 32**

**INVERTING LARGE-SIGNAL PULSE RESPONSE**



**Figure 33**

**INVERTING LARGE-SIGNAL PULSE RESPONSE**



**Figure 34**



TYPICAL CHARACTERISTICS

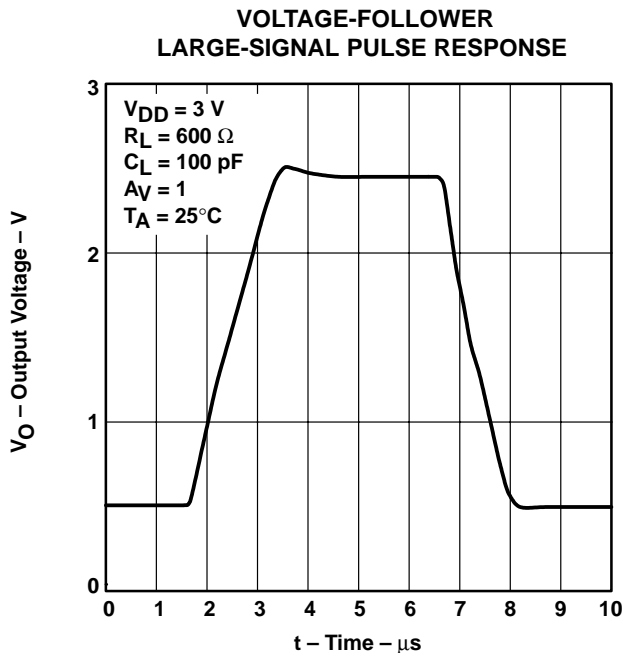


Figure 35

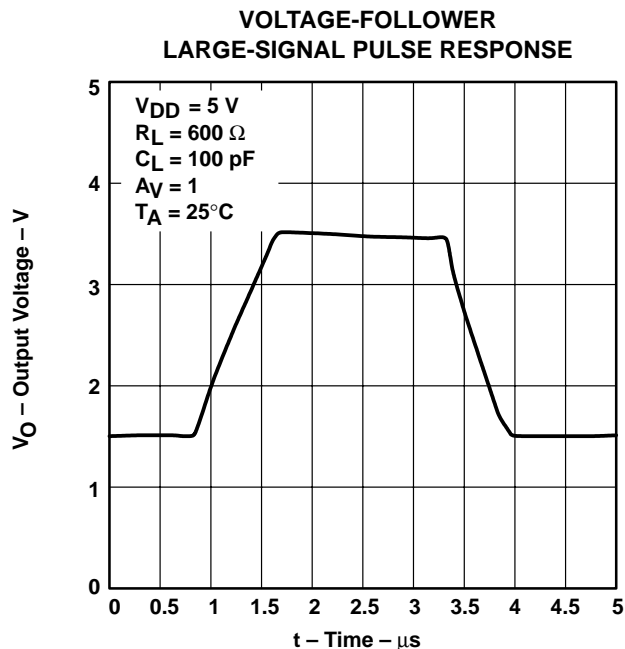


Figure 36

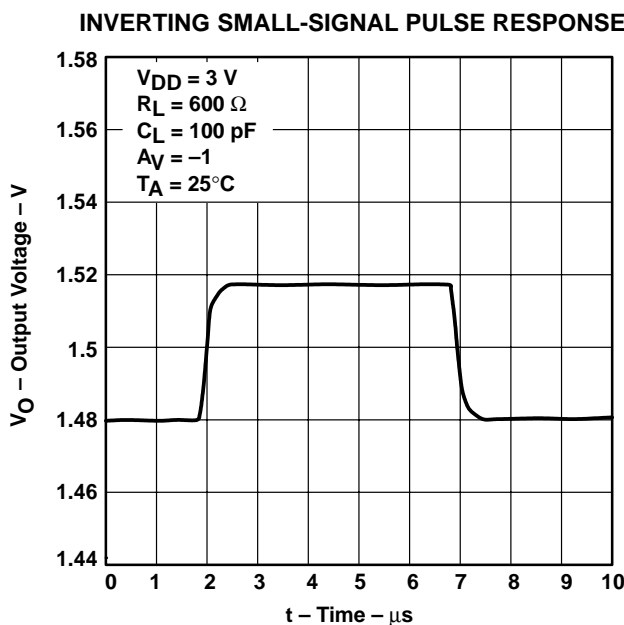


Figure 37

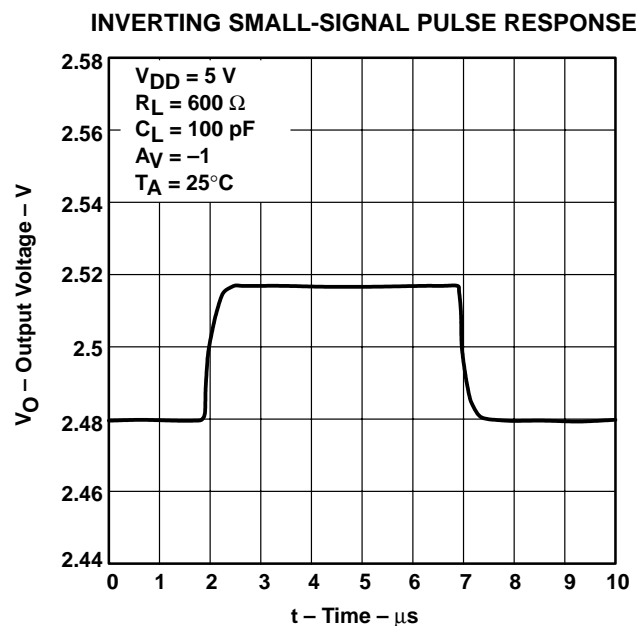


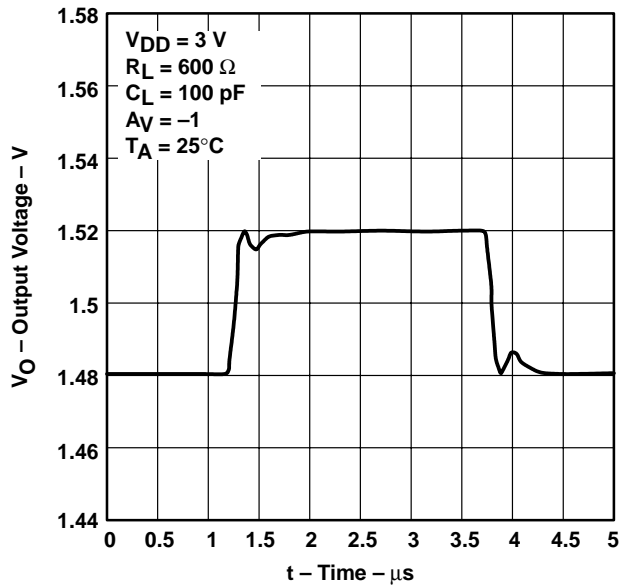
Figure 38

**TLV2442, TLV2442A, TLV2444, TLV2444A**  
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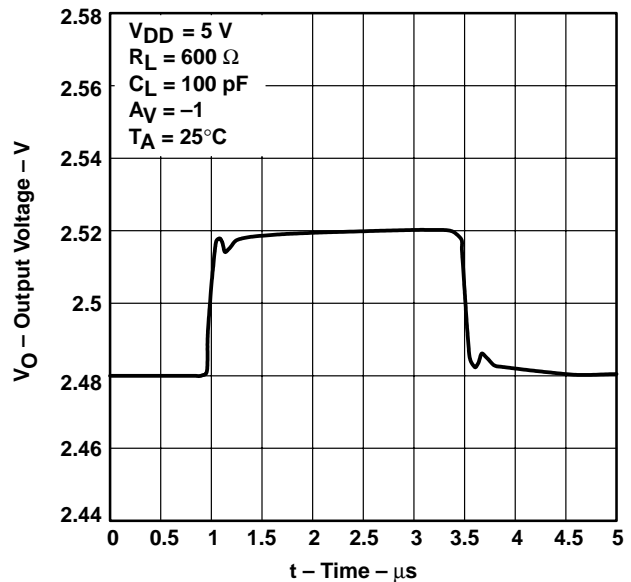
**TYPICAL CHARACTERISTICS**

**VOLTAGE-FOLLOWER  
 SMALL-SIGNAL PULSE RESPONSE**



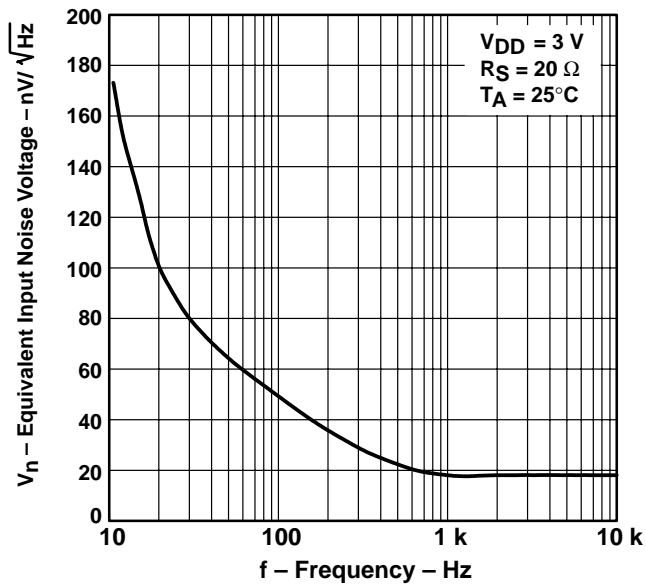
**Figure 39**

**VOLTAGE-FOLLOWER  
 SMALL-SIGNAL PULSE RESPONSE**



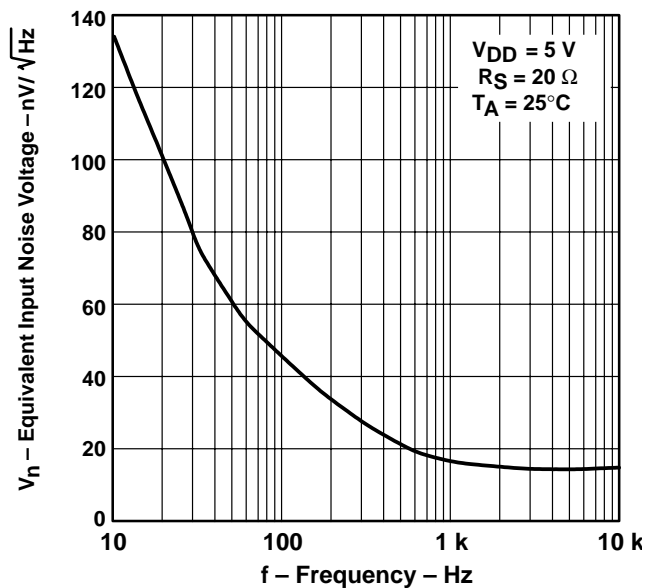
**Figure 40**

**EQUIVALENT INPUT NOISE VOLTAGE  
 VS  
 FREQUENCY**



**Figure 41**

**EQUIVALENT INPUT NOISE VOLTAGE  
 VS  
 FREQUENCY**



**Figure 42**



TYPICAL CHARACTERISTICS

NOISE VOLTAGE  
 OVER A 10-SECOND PERIOD

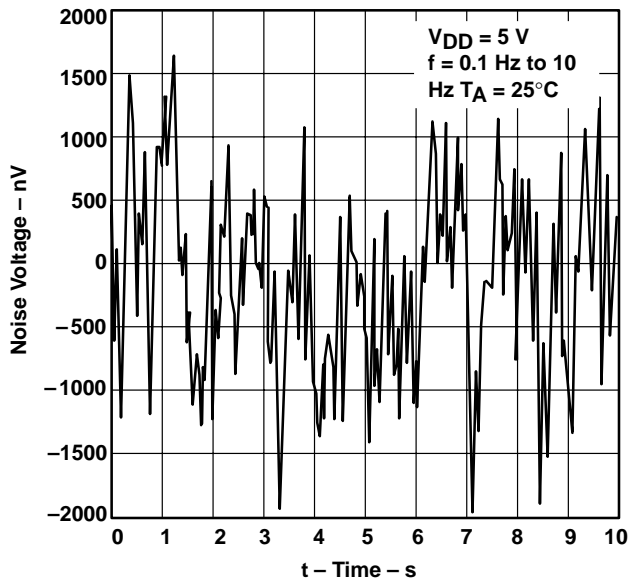


Figure 43

TOTAL HARMONIC DISTORTION PLUS NOISE  
 VS  
 FREQUENCY

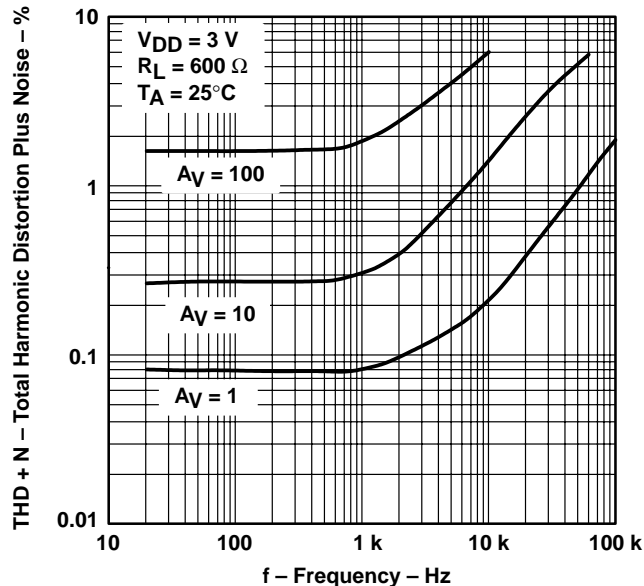


Figure 44

TOTAL HARMONIC DISTORTION PLUS NOISE  
 VS  
 FREQUENCY

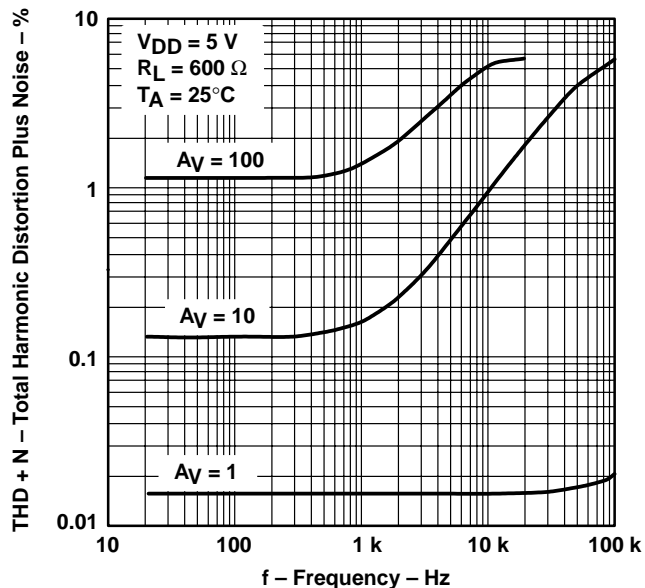


Figure 45

GAIN-BANDWIDTH PRODUCT  
 VS  
 FREE-AIR TEMPERATURE

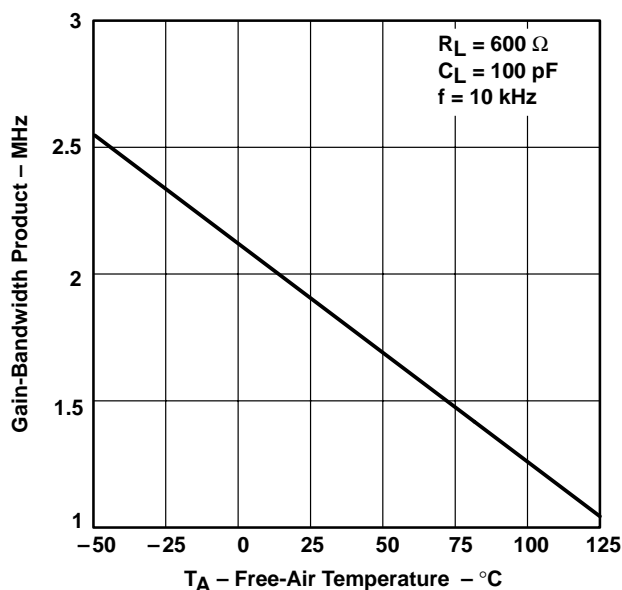


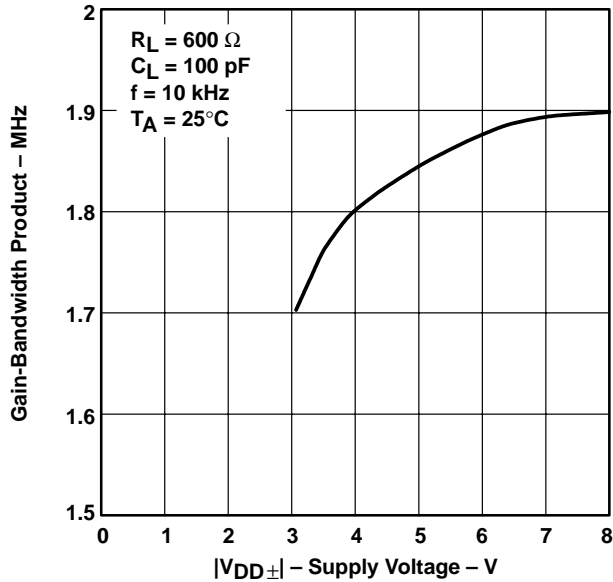
Figure 46

**TLV2442, TLV2442A, TLV2444, TLV2444A**  
**Advanced LinCMOS™ RAIL-TO-RAIL OUTPUT**  
**WIDE-INPUT-VOLTAGE OPERATIONAL AMPLIFIERS**

SLOS169H – NOVEMBER 1996 – REVISED MARCH 2001

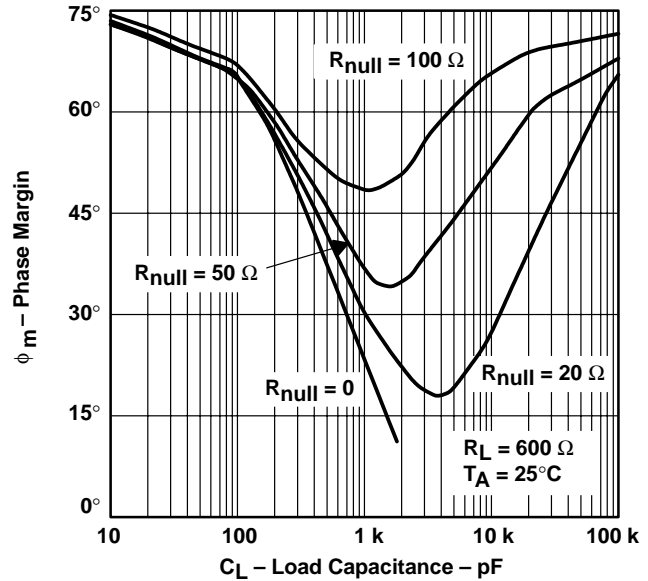
**TYPICAL CHARACTERISTICS**

**GAIN-BANDWIDTH PRODUCT**  
**vs**  
**SUPPLY VOLTAGE**



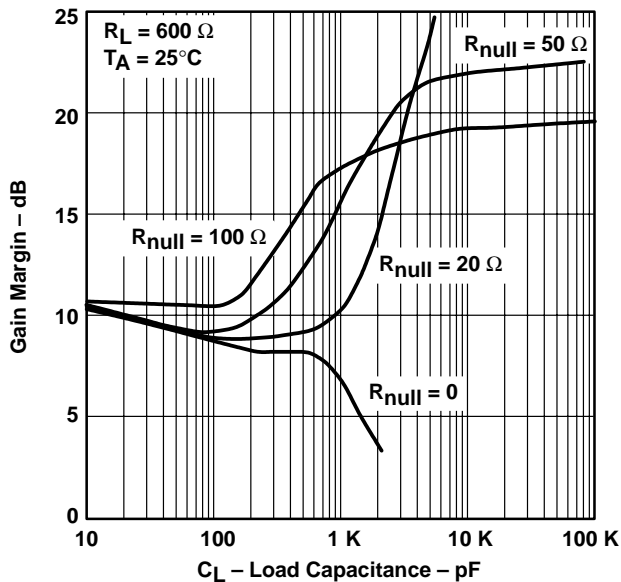
**Figure 47**

**PHASE MARGIN**  
**vs**  
**LOAD CAPACITANCE**



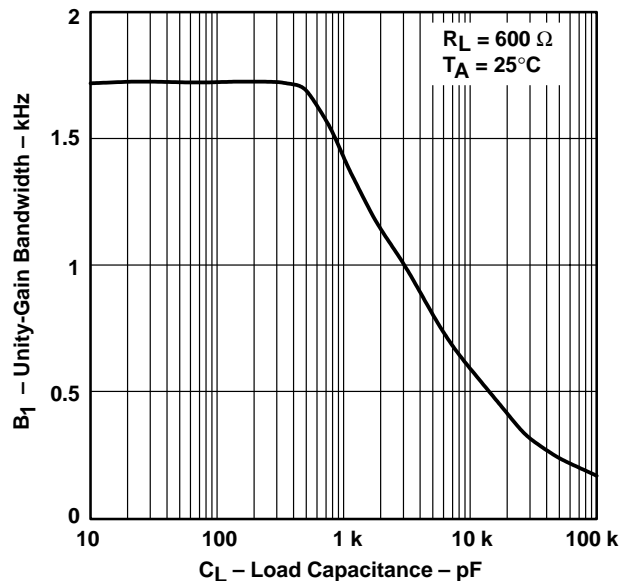
**Figure 48**

**GAIN MARGIN**  
**vs**  
**LOAD CAPACITANCE**



**Figure 49**

**UNITY-GAIN BANDWIDTH**  
**vs**  
**LOAD CAPACITANCE**



**Figure 50**



# TLV2442, TLV2442A, TLV2444, TLV2444A Advanced LinCMOS™ RAIL-TO-RAIL OUTPUT WIDE-INPUT-VOLTAGE OPERATIONAL AMPLIFIERS

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## APPLICATION INFORMATION

### macromodel information

Macromodel information provided was derived using *PSpice™ Parts™* model generation software. The Boyle macromodel (see Note 5) and subcircuit in Figure 51 were generated using the TLV244x typical electrical and operating characteristics at  $T_A = 25^\circ\text{C}$ . Using this information, output simulations of the following key parameters can be generated to a tolerance of 20% (in most cases):

- Maximum positive output voltage swing
- Maximum negative output voltage swing
- Slew rate
- Quiescent power dissipation
- Input bias current
- Open-loop voltage amplification
- Unity gain frequency
- Common-mode rejection ratio
- Phase margin
- DC output resistance
- AC output resistance
- Short-circuit output current limit

NOTE 5: G. R. Boyle, B. M. Cohn, D. O. Pederson, and J. E. Solomon, "Macromodeling of Integrated Circuit Operational Amplifiers," *IEEE Journal of Solid-State Circuits*, SC-9, 353 (1974).

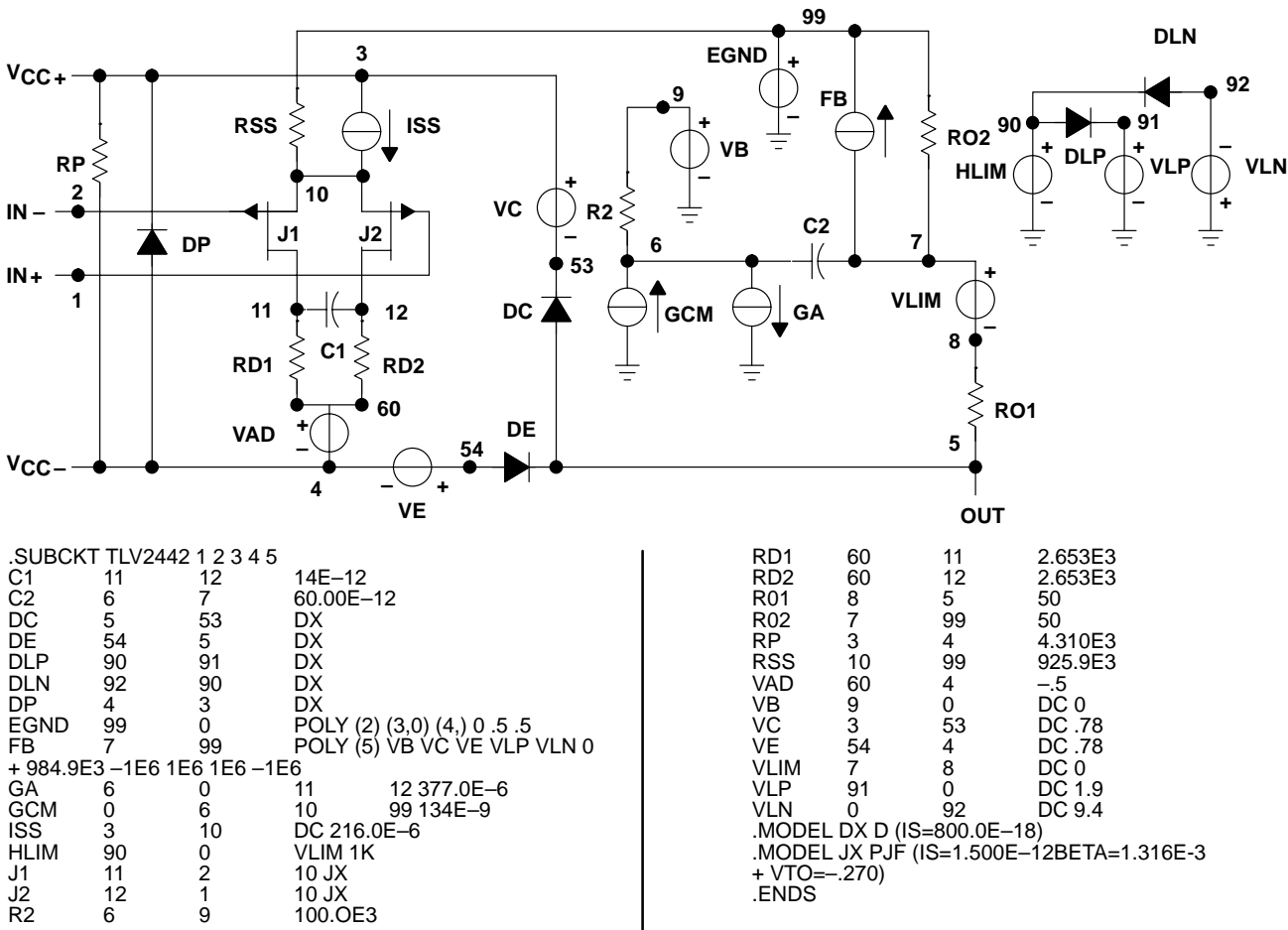


Figure 51. Boyle Macromodel and Subcircuit

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**Advanced LinCMOS™ RAIL-TO-RAIL OUTPUT**  
**WIDE-INPUT-VOLTAGE OPERATIONAL AMPLIFIERS**

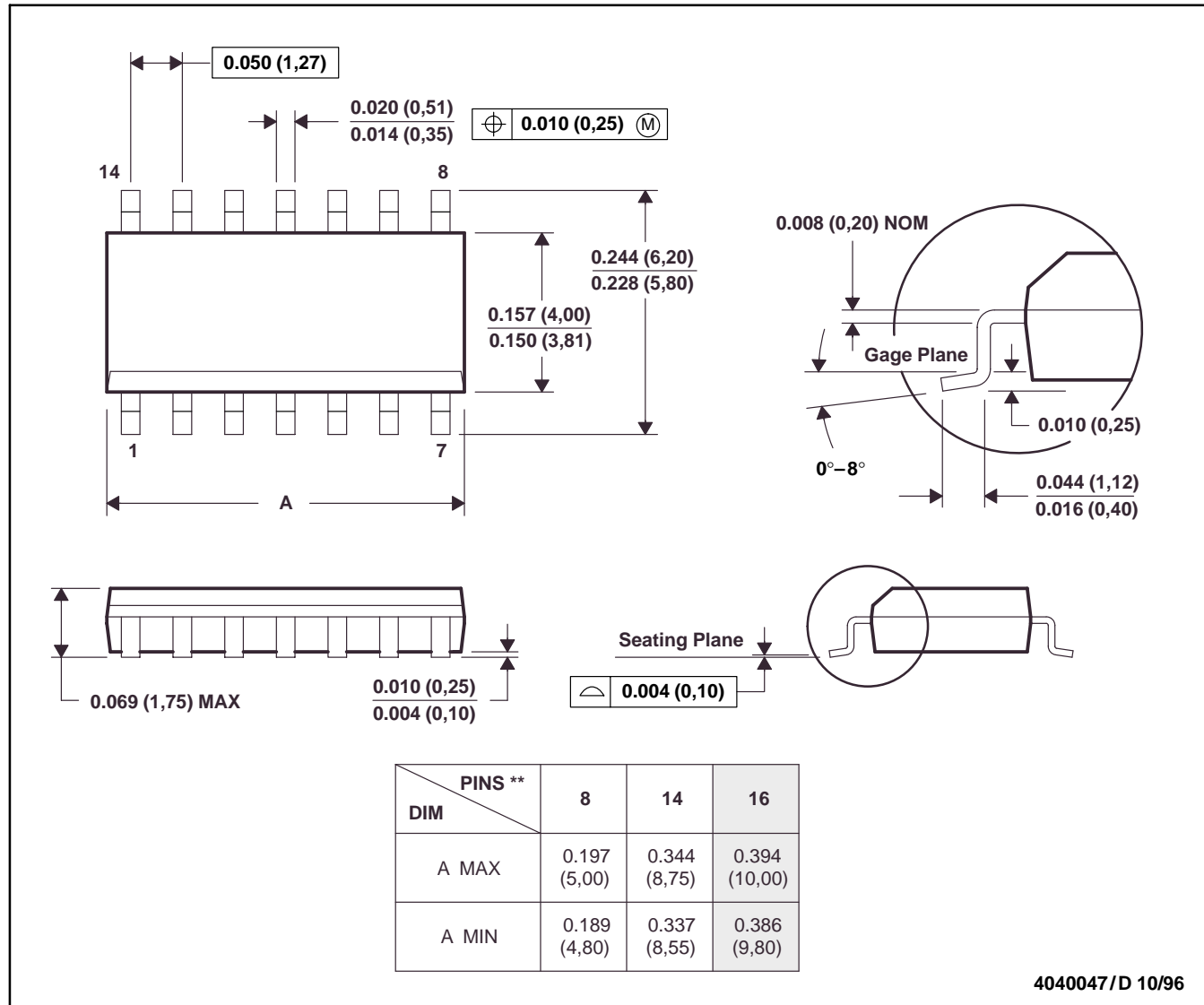
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**MECHANICAL DATA**

**D (R-PDSO-G\*\*)**

**PLASTIC SMALL-OUTLINE PACKAGE**

14 PIN SHOWN



- NOTES: A. All linear dimensions are in inches (millimeters).  
 B. This drawing is subject to change without notice.  
 C. Body dimensions do not include mold flash or protrusion, not to exceed 0.006 (0,15).  
 D. Falls within JEDEC MS-012



**TLV2442, TLV2442A, TLV2444, TLV2444A**  
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**WIDE-INPUT-VOLTAGE OPERATIONAL AMPLIFIERS**

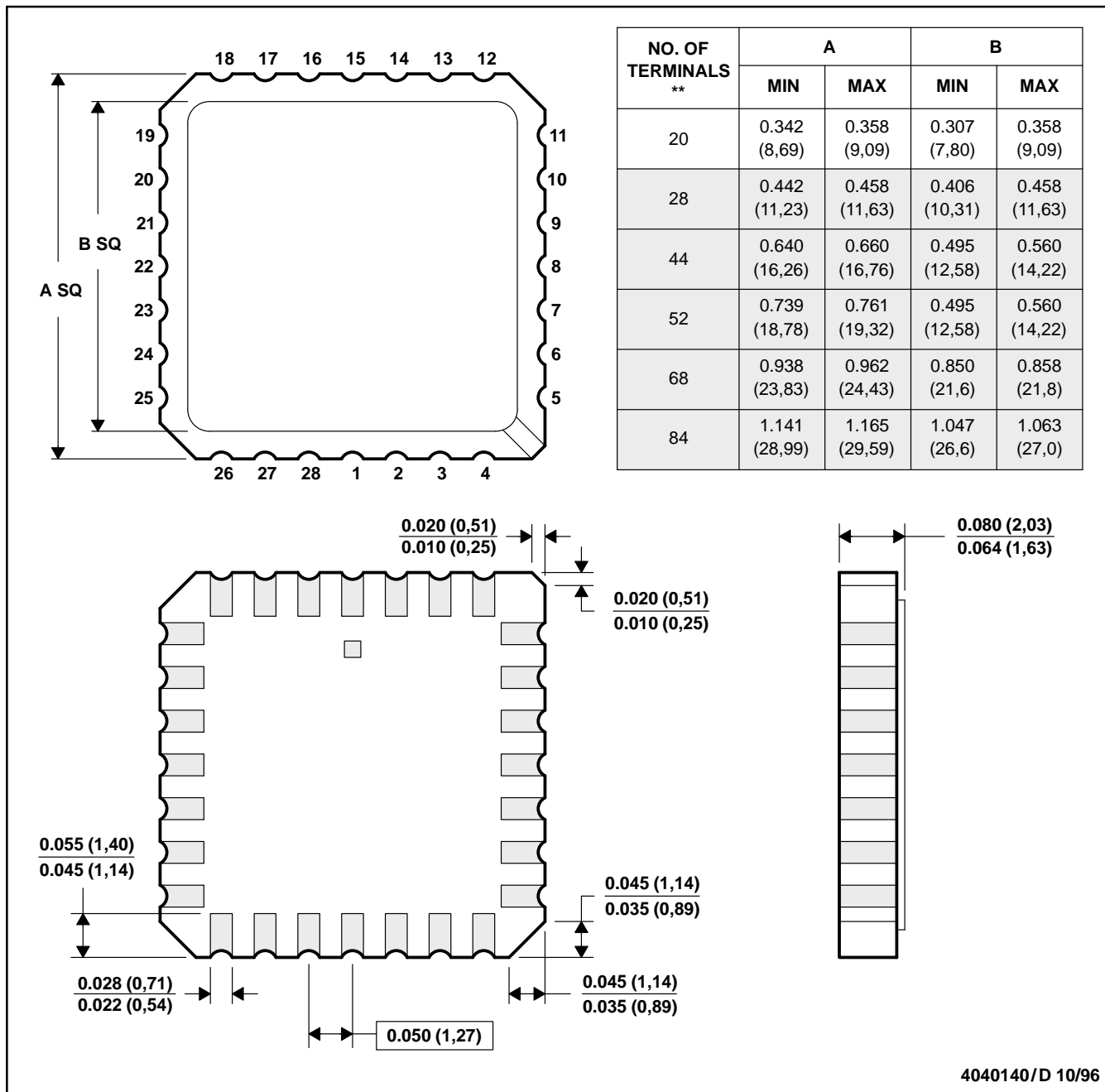
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**MECHANICAL DATA**

**FK (S-CQCC-N\*\*)**

**LEADLESS CERAMIC CHIP CARRIER**

28 TERMINAL SHOWN



- NOTES: A. All linear dimensions are in inches (millimeters).  
 B. This drawing is subject to change without notice.  
 C. This package can be hermetically sealed with a metal lid.  
 D. The terminals are gold plated.  
 E. Falls within JEDEC MS-004

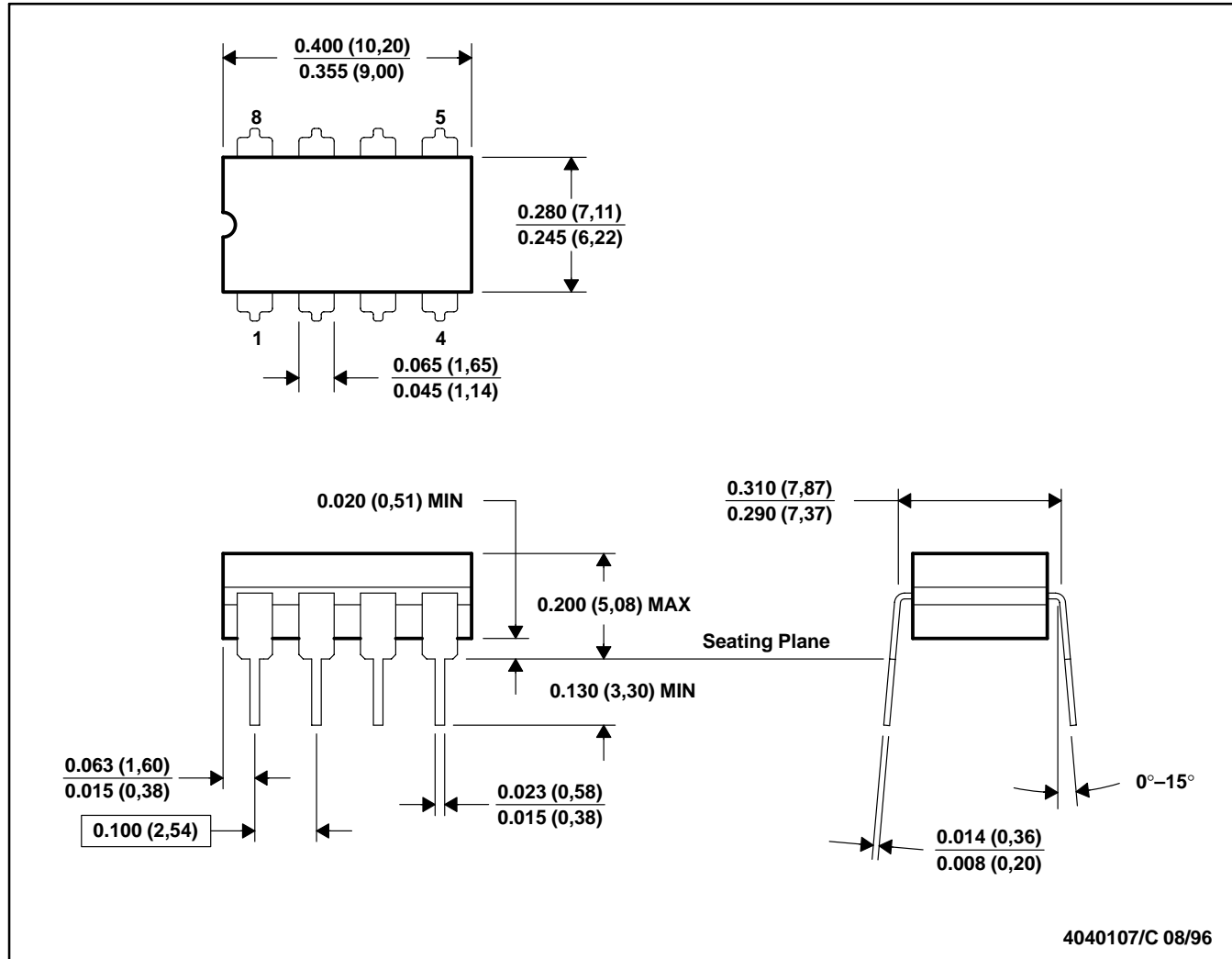
**TLV2442, TLV2442A, TLV2444, TLV2444A**  
**Advanced LinCMOS™ RAIL-TO-RAIL OUTPUT**  
**WIDE-INPUT-VOLTAGE OPERATIONAL AMPLIFIERS**

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**MECHANICAL DATA**

**JG (R-GDIP-T8)**

**CERAMIC DUAL-IN-LINE PACKAGE**



- NOTES: A. All linear dimensions are in inches (millimeters).  
 B. This drawing is subject to change without notice.  
 C. This package can be hermetically sealed with a ceramic lid using glass frit.  
 D. Index point is provided on cap for terminal identification on press ceramic glass frit seal only.  
 E. Falls within MIL-STD-1835 GDIP1-T8



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**TLV2442, TLV2442A, TLV2444, TLV2444A**  
**Advanced LinCMOS™ RAIL-TO-RAIL OUTPUT**  
**WIDE-INPUT-VOLTAGE OPERATIONAL AMPLIFIERS**

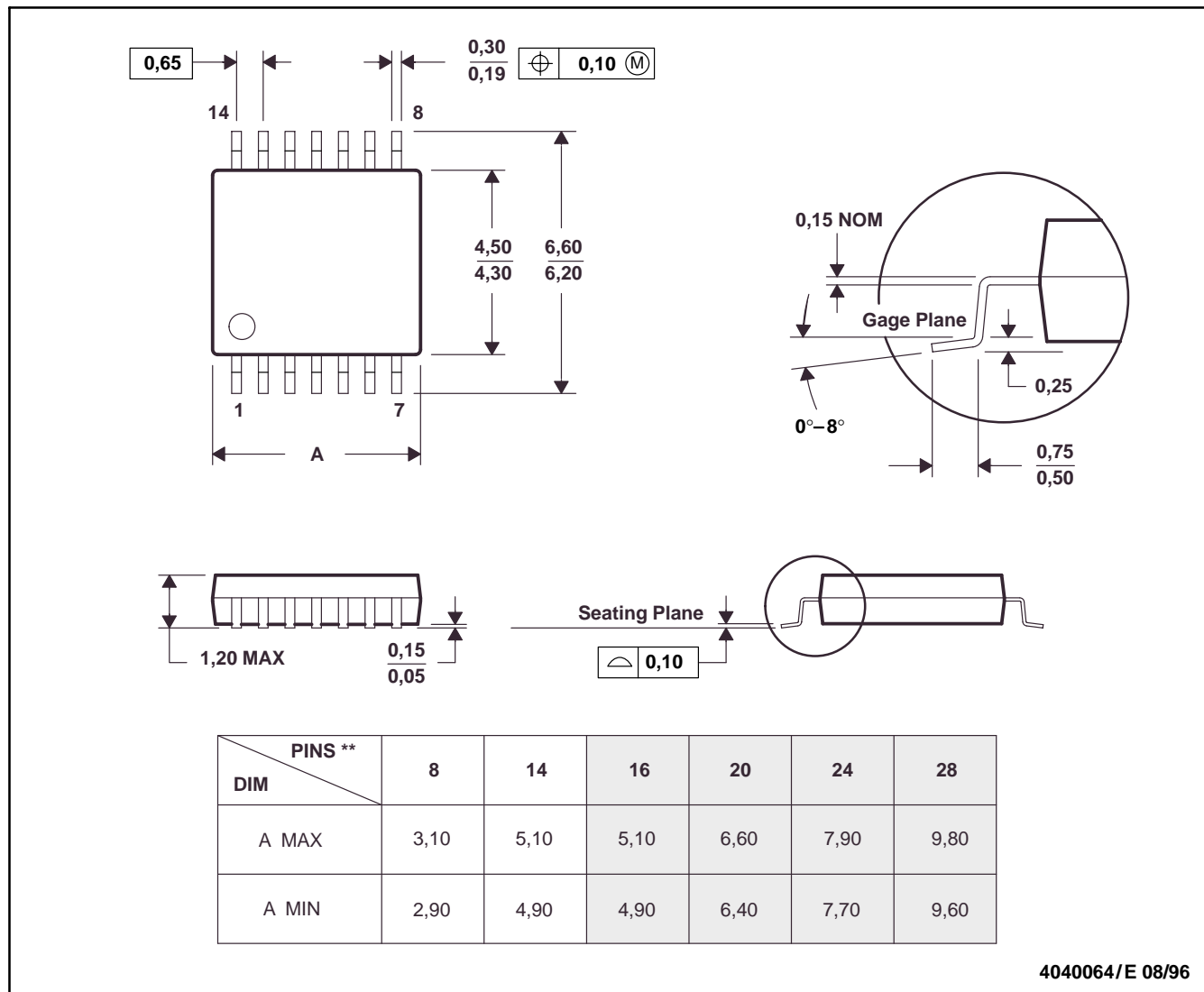
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**MECHANICAL DATA**

**PW (R-PDSO-G\*\*)**

**PLASTIC SMALL-OUTLINE PACKAGE**

14 PIN SHOWN



4040064/E 08/96

- NOTES: A. All linear dimensions are in millimeters.  
 B. This drawing is subject to change without notice.  
 C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.  
 D. Falls within JEDEC MO-153

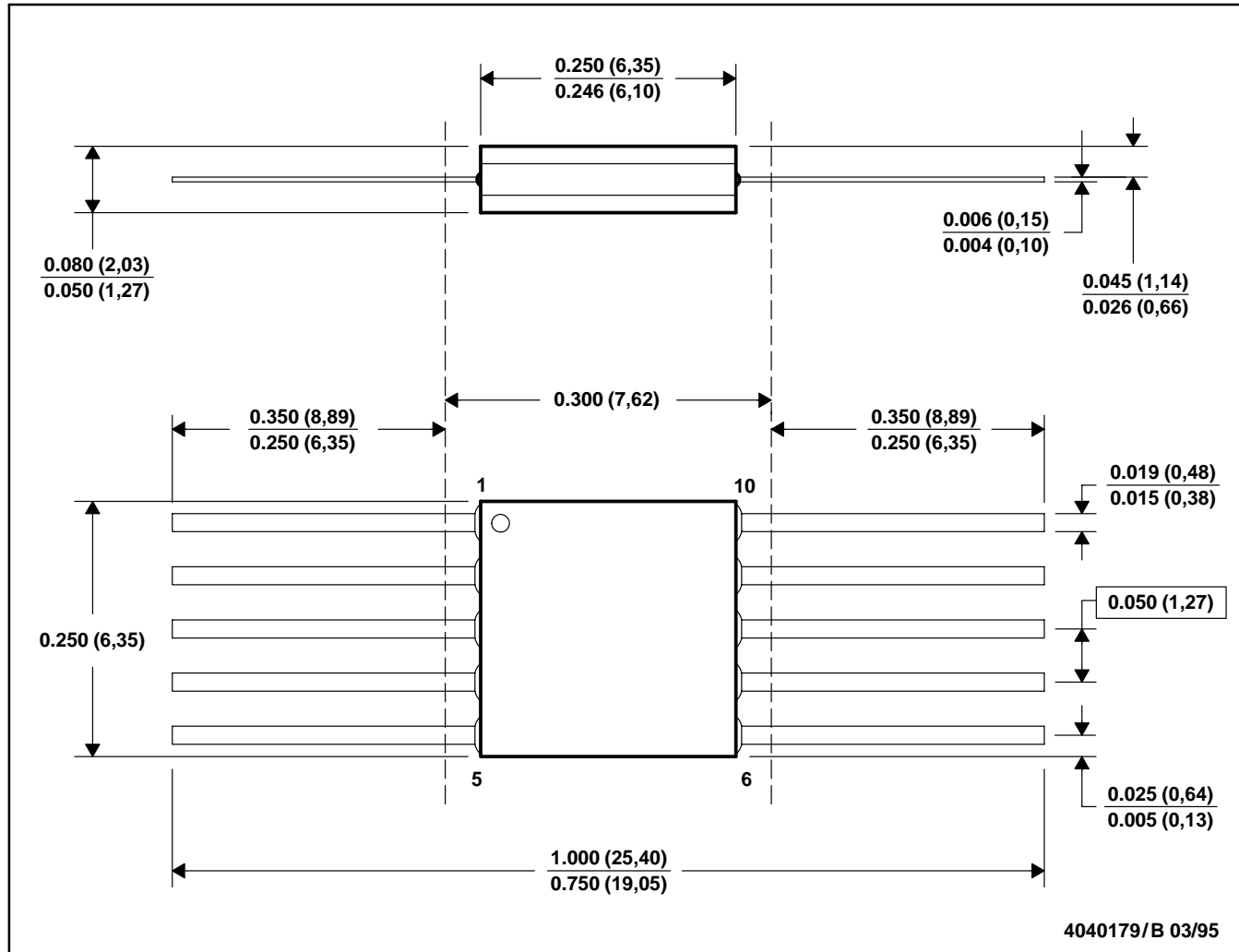
**TLV2442, TLV2442A, TLV2444, TLV2444A**  
**Advanced LinCMOS™ RAIL-TO-RAIL OUTPUT**  
**WIDE-INPUT-VOLTAGE OPERATIONAL AMPLIFIERS**

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**MECHANICAL DATA**

**U (S-GDFP-F10)**

**CERAMIC DUAL FLATPACK**



- NOTES: A. All linear dimensions are in inches (millimeters).  
 B. This drawing is subject to change without notice.  
 C. This package can be hermetically sealed with a ceramic lid using glass frit.  
 D. Index point is provided on cap for terminal identification only.  
 E. Falls within MIL STD 1835 GDFP1-F10 and JEDEC MO-092AA



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**PACKAGING INFORMATION**

| Orderable Device | Status <sup>(1)</sup> | Package Type | Package Drawing | Pins | Package Qty | Eco Plan <sup>(2)</sup> | Lead/Ball Finish | MSL Peak Temp <sup>(3)</sup> |
|------------------|-----------------------|--------------|-----------------|------|-------------|-------------------------|------------------|------------------------------|
| 5962-9751101Q2A  | ACTIVE                | LCCC         | FK              | 20   | 1           | TBD                     | POST-PLATE       | N / A for Pkg Type           |
| 5962-9751101QHA  | ACTIVE                | CFP          | U               | 10   | 1           | TBD                     | A42 SNPB         | N / A for Pkg Type           |
| 5962-9751101QPA  | ACTIVE                | CDIP         | JG              | 8    | 1           | TBD                     | A42 SNPB         | N / A for Pkg Type           |
| 5962-9751102Q2A  | ACTIVE                | LCCC         | FK              | 20   | 1           | TBD                     | POST-PLATE       | N / A for Pkg Type           |
| 5962-9751102QHA  | ACTIVE                | CFP          | U               | 10   | 1           | TBD                     | A42 SNPB         | N / A for Pkg Type           |
| 5962-9751102QPA  | ACTIVE                | CDIP         | JG              | 8    | 1           | TBD                     | A42 SNPB         | N / A for Pkg Type           |
| TLV2442AID       | ACTIVE                | SOIC         | D               | 8    | 75          | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| TLV2442AIDG4     | ACTIVE                | SOIC         | D               | 8    | 75          | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| TLV2442AIDR      | ACTIVE                | SOIC         | D               | 8    | 2500        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| TLV2442AIDRG4    | ACTIVE                | SOIC         | D               | 8    | 2500        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| TLV2442AIPW      | ACTIVE                | TSSOP        | PW              | 8    | 150         | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| TLV2442AIPWG4    | ACTIVE                | TSSOP        | PW              | 8    | 150         | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| TLV2442AIPWLE    | OBSOLETE              | TSSOP        | PW              | 8    |             | TBD                     | Call TI          | Call TI                      |
| TLV2442AIPWR     | ACTIVE                | TSSOP        | PW              | 8    | 2000        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| TLV2442AIPWRG4   | ACTIVE                | TSSOP        | PW              | 8    | 2000        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| TLV2442AMFKB     | ACTIVE                | LCCC         | FK              | 20   | 1           | TBD                     | POST-PLATE       | N / A for Pkg Type           |
| TLV2442AMJGB     | ACTIVE                | CDIP         | JG              | 8    | 1           | TBD                     | A42 SNPB         | N / A for Pkg Type           |
| TLV2442AMUB      | ACTIVE                | CFP          | U               | 10   | 1           | TBD                     | A42 SNPB         | N / A for Pkg Type           |
| TLV2442AQD       | NRND                  | SOIC         | D               | 8    | 75          | TBD                     | CU NIPDAU        | Level-1-220C-UNLIM           |
| TLV2442AQDG4     | NRND                  | SOIC         | D               | 8    | 75          | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| TLV2442AQDR      | NRND                  | SOIC         | D               | 8    | 2500        | TBD                     | CU NIPDAU        | Level-1-220C-UNLIM           |
| TLV2442AQDRG4    | NRND                  | SOIC         | D               | 8    | 2500        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| TLV2442AQPW      | ACTIVE                | TSSOP        | PW              | 8    | 150         | TBD                     | CU NIPDAU        | Level-1-220C-UNLIM           |
| TLV2442AQPWG4    | ACTIVE                | TSSOP        | PW              | 8    | 150         | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| TLV2442AQPWR     | ACTIVE                | TSSOP        | PW              | 8    | 2000        | TBD                     | CU NIPDAU        | Level-1-220C-UNLIM           |
| TLV2442AQPWRG4   | ACTIVE                | TSSOP        | PW              | 8    | 2000        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| TLV2442AQPWRG4Q1 | ACTIVE                | TSSOP        | PW              | 8    | 2000        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| TLV2442CD        | ACTIVE                | SOIC         | D               | 8    | 75          | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| TLV2442CDG4      | ACTIVE                | SOIC         | D               | 8    | 75          | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| TLV2442CDR       | ACTIVE                | SOIC         | D               | 8    | 2500        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| TLV2442CDRG4     | ACTIVE                | SOIC         | D               | 8    | 2500        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |

| Orderable Device | Status <sup>(1)</sup> | Package Type | Package Drawing | Pins | Package Qty | Eco Plan <sup>(2)</sup> | Lead/Ball Finish | MSL Peak Temp <sup>(3)</sup> |
|------------------|-----------------------|--------------|-----------------|------|-------------|-------------------------|------------------|------------------------------|
|                  |                       |              |                 |      |             | no Sb/Br)               |                  |                              |
| TLV2442CPW       | ACTIVE                | TSSOP        | PW              | 8    | 150         | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| TLV2442CPWG4     | ACTIVE                | TSSOP        | PW              | 8    | 150         | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| TLV2442CPWLE     | OBSOLETE              | TSSOP        | PW              | 8    |             | TBD                     | Call TI          | Call TI                      |
| TLV2442CPWR      | ACTIVE                | TSSOP        | PW              | 8    | 2000        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| TLV2442CPWRG4    | ACTIVE                | TSSOP        | PW              | 8    | 2000        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| TLV2442ID        | ACTIVE                | SOIC         | D               | 8    | 75          | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| TLV2442IDG4      | ACTIVE                | SOIC         | D               | 8    | 75          | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| TLV2442IDR       | ACTIVE                | SOIC         | D               | 8    | 2500        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| TLV2442IDRG4     | ACTIVE                | SOIC         | D               | 8    | 2500        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| TLV2442IPWRG4    | ACTIVE                | TSSOP        | PW              | 8    |             | TBD                     | Call TI          | Call TI                      |
| TLV2442MFKB      | ACTIVE                | LCCC         | FK              | 20   | 1           | TBD                     | POST-PLATE       | N / A for Pkg Type           |
| TLV2442MJGB      | ACTIVE                | CDIP         | JG              | 8    | 1           | TBD                     | A42 SNPB         | N / A for Pkg Type           |
| TLV2442MUB       | ACTIVE                | CFP          | U               | 10   | 1           | TBD                     | A42 SNPB         | N / A for Pkg Type           |
| TLV2442QD        | NRND                  | SOIC         | D               | 8    | 75          | TBD                     | CU NIPDAU        | Level-1-220C-UNLIM           |
| TLV2442QDG4      | NRND                  | SOIC         | D               | 8    | 75          | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| TLV2442QDR       | NRND                  | SOIC         | D               | 8    | 2500        | TBD                     | CU NIPDAU        | Level-1-220C-UNLIM           |
| TLV2442QDRG4     | NRND                  | SOIC         | D               | 8    | 2500        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| TLV2442QPW       | ACTIVE                | TSSOP        | PW              | 8    | 150         | TBD                     | CU NIPDAU        | Level-1-220C-UNLIM           |
| TLV2442QPWG4     | ACTIVE                | TSSOP        | PW              | 8    | 150         | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| TLV2442QPWR      | ACTIVE                | TSSOP        | PW              | 8    | 2000        | TBD                     | CU NIPDAU        | Level-1-220C-UNLIM           |
| TLV2442QPWRG4    | ACTIVE                | TSSOP        | PW              | 8    | 2000        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| TLV2442QPWRG4Q1  | ACTIVE                | TSSOP        | PW              | 8    | 2000        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| TLV2444AID       | ACTIVE                | SOIC         | D               | 14   | 50          | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| TLV2444AIDG4     | ACTIVE                | SOIC         | D               | 14   | 50          | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| TLV2444AIDRG4    | ACTIVE                | SOIC         | D               | 14   |             | TBD                     | Call TI          | Call TI                      |
| TLV2444AIPW      | ACTIVE                | TSSOP        | PW              | 14   | 90          | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| TLV2444AIPWG4    | ACTIVE                | TSSOP        | PW              | 14   | 90          | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| TLV2444AIPWR     | ACTIVE                | TSSOP        | PW              | 14   | 2000        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| TLV2444AIPWRG4   | ACTIVE                | TSSOP        | PW              | 14   | 2000        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |

| Orderable Device | Status <sup>(1)</sup> | Package Type | Package Drawing | Pins | Package Qty | Eco Plan <sup>(2)</sup> | Lead/Ball Finish | MSL Peak Temp <sup>(3)</sup> |
|------------------|-----------------------|--------------|-----------------|------|-------------|-------------------------|------------------|------------------------------|
| TLV2444CD        | ACTIVE                | SOIC         | D               | 14   | 50          | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| TLV2444CDG4      | ACTIVE                | SOIC         | D               | 14   | 50          | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| TLV2444CDR       | ACTIVE                | SOIC         | D               | 14   | 2500        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| TLV2444CDRG4     | ACTIVE                | SOIC         | D               | 14   | 2500        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| TLV2444CPW       | ACTIVE                | TSSOP        | PW              | 14   | 90          | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| TLV2444CPWG4     | ACTIVE                | TSSOP        | PW              | 14   | 90          | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| TLV2444CPWR      | ACTIVE                | TSSOP        | PW              | 14   | 2000        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| TLV2444CPWRG4    | ACTIVE                | TSSOP        | PW              | 14   | 2000        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| TLV2444ID        | ACTIVE                | SOIC         | D               | 14   | 50          | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| TLV2444IDG4      | ACTIVE                | SOIC         | D               | 14   | 50          | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| TLV2444IDR       | ACTIVE                | SOIC         | D               | 14   | 2500        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| TLV2444IDRG4     | ACTIVE                | SOIC         | D               | 14   | 2500        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| TLV2444IPWR      | ACTIVE                | TSSOP        | PW              | 14   | 2000        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| TLV2444IPWRG4    | ACTIVE                | TSSOP        | PW              | 14   | 2000        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |

<sup>(1)</sup> The marketing status values are defined as follows:

**ACTIVE:** Product device recommended for new designs.

**LIFEBUY:** TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

**NRND:** Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

**PREVIEW:** Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

<sup>(2)</sup> Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check <http://www.ti.com/productcontent> for the latest availability information and additional product content details.

**TBD:** The Pb-Free/Green conversion plan has not been defined.

**Pb-Free (RoHS):** TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

**Pb-Free (RoHS Exempt):** This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

**Green (RoHS & no Sb/Br):** TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

<sup>(3)</sup> MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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**TAPE AND REEL INFORMATION**



**QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE**



\*All dimensions are nominal

| Device       | Package Type | Package Drawing | Pins | SPQ  | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|--------------|--------------|-----------------|------|------|--------------------|--------------------|---------|---------|---------|---------|--------|---------------|
| TLV2442AIDR  | SOIC         | D               | 8    | 2500 | 330.0              | 12.4               | 6.4     | 5.2     | 2.1     | 8.0     | 12.0   | Q1            |
| TLV2442AIPWR | TSSOP        | PW              | 8    | 2000 | 330.0              | 12.4               | 7.0     | 3.6     | 1.6     | 8.0     | 12.0   | Q1            |
| TLV2442CDR   | SOIC         | D               | 8    | 2500 | 330.0              | 12.4               | 6.4     | 5.2     | 2.1     | 8.0     | 12.0   | Q1            |
| TLV2442CPWR  | TSSOP        | PW              | 8    | 2000 | 330.0              | 12.4               | 7.0     | 3.6     | 1.6     | 8.0     | 12.0   | Q1            |
| TLV2442IDR   | SOIC         | D               | 8    | 2500 | 330.0              | 12.4               | 6.4     | 5.2     | 2.1     | 8.0     | 12.0   | Q1            |
| TLV2444AIPWR | TSSOP        | PW              | 14   | 2000 | 330.0              | 12.4               | 7.0     | 5.6     | 1.6     | 8.0     | 12.0   | Q1            |
| TLV2444CDR   | SOIC         | D               | 14   | 2500 | 330.0              | 16.4               | 6.5     | 9.0     | 2.1     | 8.0     | 16.0   | Q1            |
| TLV2444CPWR  | TSSOP        | PW              | 14   | 2000 | 330.0              | 12.4               | 7.0     | 5.6     | 1.6     | 8.0     | 12.0   | Q1            |
| TLV2444IDR   | SOIC         | D               | 14   | 2500 | 330.0              | 16.4               | 6.5     | 9.0     | 2.1     | 8.0     | 16.0   | Q1            |
| TLV2444IPWR  | TSSOP        | PW              | 14   | 2000 | 330.0              | 12.4               | 7.0     | 5.6     | 1.6     | 8.0     | 12.0   | Q1            |

**TAPE AND REEL BOX DIMENSIONS**



\*All dimensions are nominal

| Device       | Package Type | Package Drawing | Pins | SPQ  | Length (mm) | Width (mm) | Height (mm) |
|--------------|--------------|-----------------|------|------|-------------|------------|-------------|
| TLV2442AIDR  | SOIC         | D               | 8    | 2500 | 346.0       | 346.0      | 29.0        |
| TLV2442AIPWR | TSSOP        | PW              | 8    | 2000 | 346.0       | 346.0      | 29.0        |
| TLV2442CDR   | SOIC         | D               | 8    | 2500 | 346.0       | 346.0      | 29.0        |
| TLV2442CPWR  | TSSOP        | PW              | 8    | 2000 | 346.0       | 346.0      | 29.0        |
| TLV2442IDR   | SOIC         | D               | 8    | 2500 | 346.0       | 346.0      | 29.0        |
| TLV2444AIPWR | TSSOP        | PW              | 14   | 2000 | 346.0       | 346.0      | 29.0        |
| TLV2444CDR   | SOIC         | D               | 14   | 2500 | 346.0       | 346.0      | 33.0        |
| TLV2444CPWR  | TSSOP        | PW              | 14   | 2000 | 346.0       | 346.0      | 29.0        |
| TLV2444IDR   | SOIC         | D               | 14   | 2500 | 346.0       | 346.0      | 33.0        |
| TLV2444IPWR  | TSSOP        | PW              | 14   | 2000 | 346.0       | 346.0      | 29.0        |

PW (R-PDSO-G\*\*)

PLASTIC SMALL-OUTLINE PACKAGE

14 PINS SHOWN

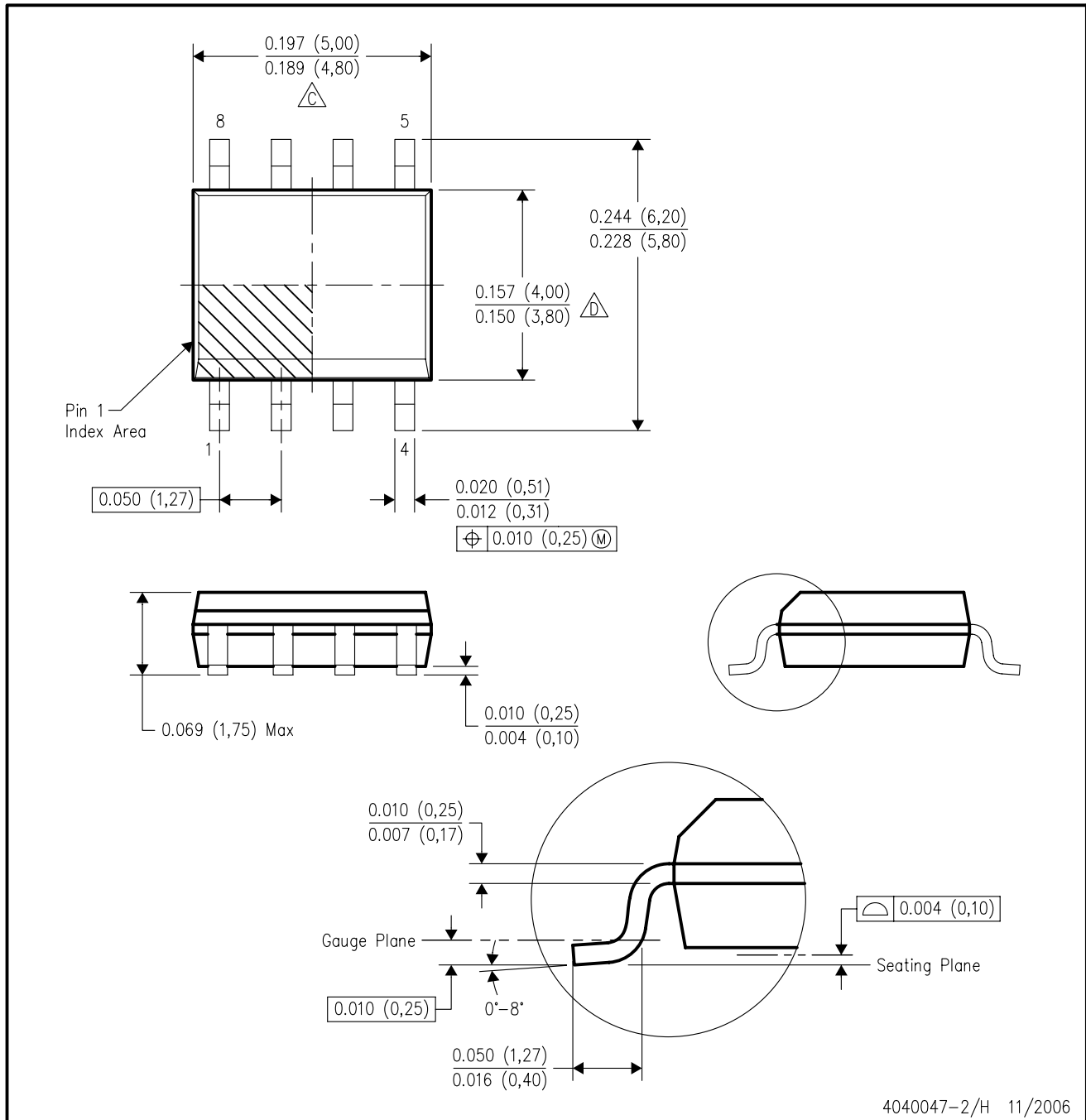


4040064/F 01/97

- NOTES: A. All linear dimensions are in millimeters.  
 B. This drawing is subject to change without notice.  
 C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.  
 D. Falls within JEDEC MO-153

D (R-PDSO-G8)

PLASTIC SMALL-OUTLINE PACKAGE



- NOTES:
- A. All linear dimensions are in inches (millimeters).
  - B. This drawing is subject to change without notice.
  - C. Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed .006 (0,15) per end.
  - D. Body width does not include interlead flash. Interlead flash shall not exceed .017 (0,43) per side.
  - E. Reference JEDEC MS-012 variation AA.

FK (S-CQCC-N\*\*)

LEADLESS CERAMIC CHIP CARRIER

28 TERMINAL SHOWN



- NOTES:
- A. All linear dimensions are in inches (millimeters).
  - B. This drawing is subject to change without notice.
  - C. This package can be hermetically sealed with a metal lid.
  - D. The terminals are gold plated.
  - E. Falls within JEDEC MS-004

D (R-PDSO-G14)

PLASTIC SMALL-OUTLINE PACKAGE



- NOTES:
- A. All linear dimensions are in inches (millimeters).
  - B. This drawing is subject to change without notice.
  - $\triangle C$  Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed .006 (0,15) per end.
  - $\triangle D$  Body width does not include interlead flash. Interlead flash shall not exceed .017 (0,43) per side.
  - E. Reference JEDEC MS-012 variation AB.

JG (R-GDIP-T8)

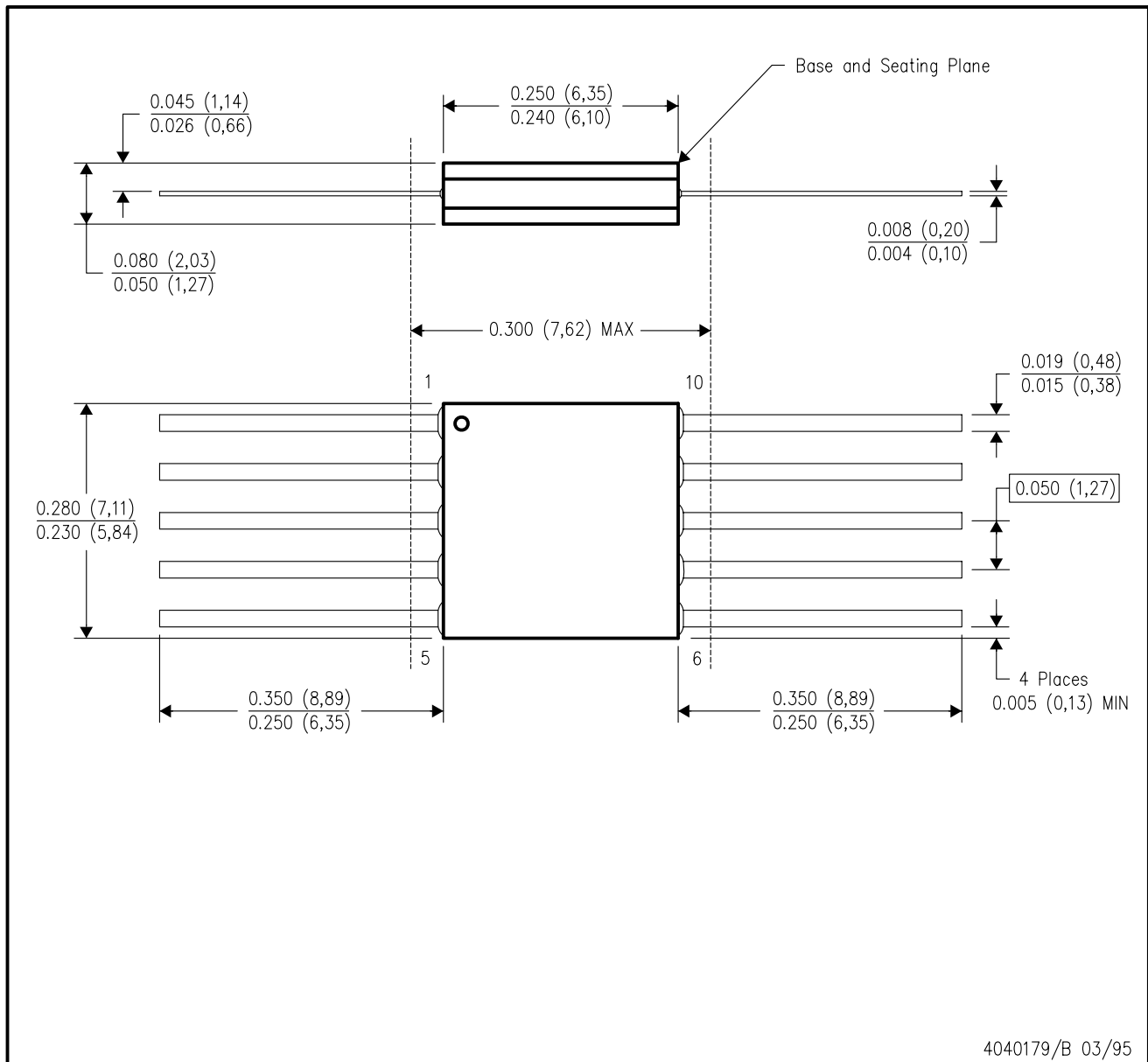
CERAMIC DUAL-IN-LINE



- NOTES: A. All linear dimensions are in inches (millimeters).  
 B. This drawing is subject to change without notice.  
 C. This package can be hermetically sealed with a ceramic lid using glass frit.  
 D. Index point is provided on cap for terminal identification.  
 E. Falls within MIL STD 1835 GDIP1-T8

U (S-GDFP-F10)

CERAMIC DUAL FLATPACK



- NOTES:
- All linear dimensions are in inches (millimeters).
  - This drawing is subject to change without notice.
  - This package can be hermetically sealed with a ceramic lid using glass frit.
  - Index point is provided on cap for terminal identification only.
  - Falls within MIL STD 1835 GDFP1-F10 and JEDEC MO-092AA



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